

Progress on Laser Assisted Discharge Produced Plasma (LDP) EUV Light Source Technology

2012 International Symposium on EUV
Lithography
Brussels, October 2012

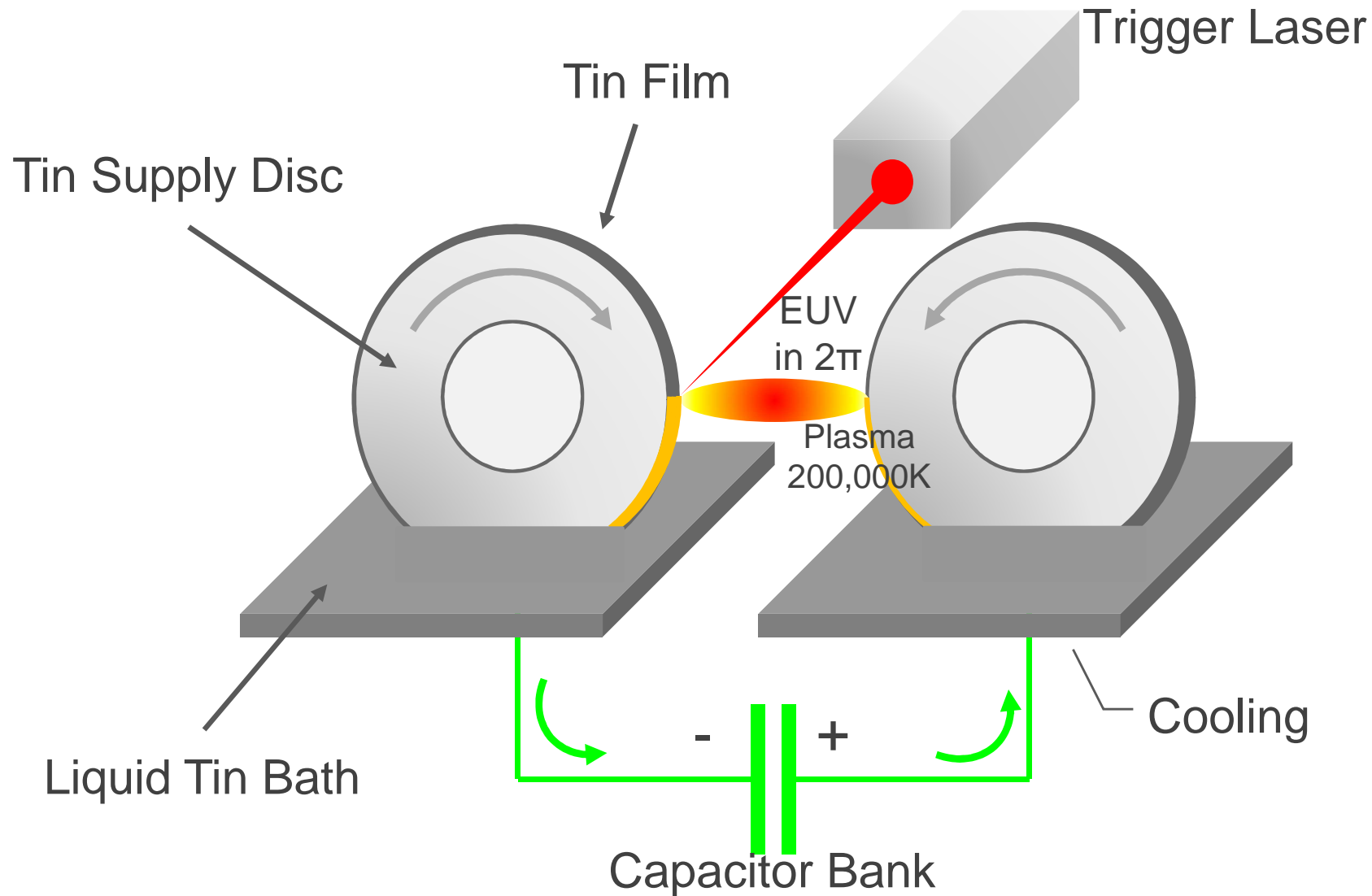


USHIO
GROUP

Please visit
Poster
P-SO-14
Rolf Apetz,
XTREME

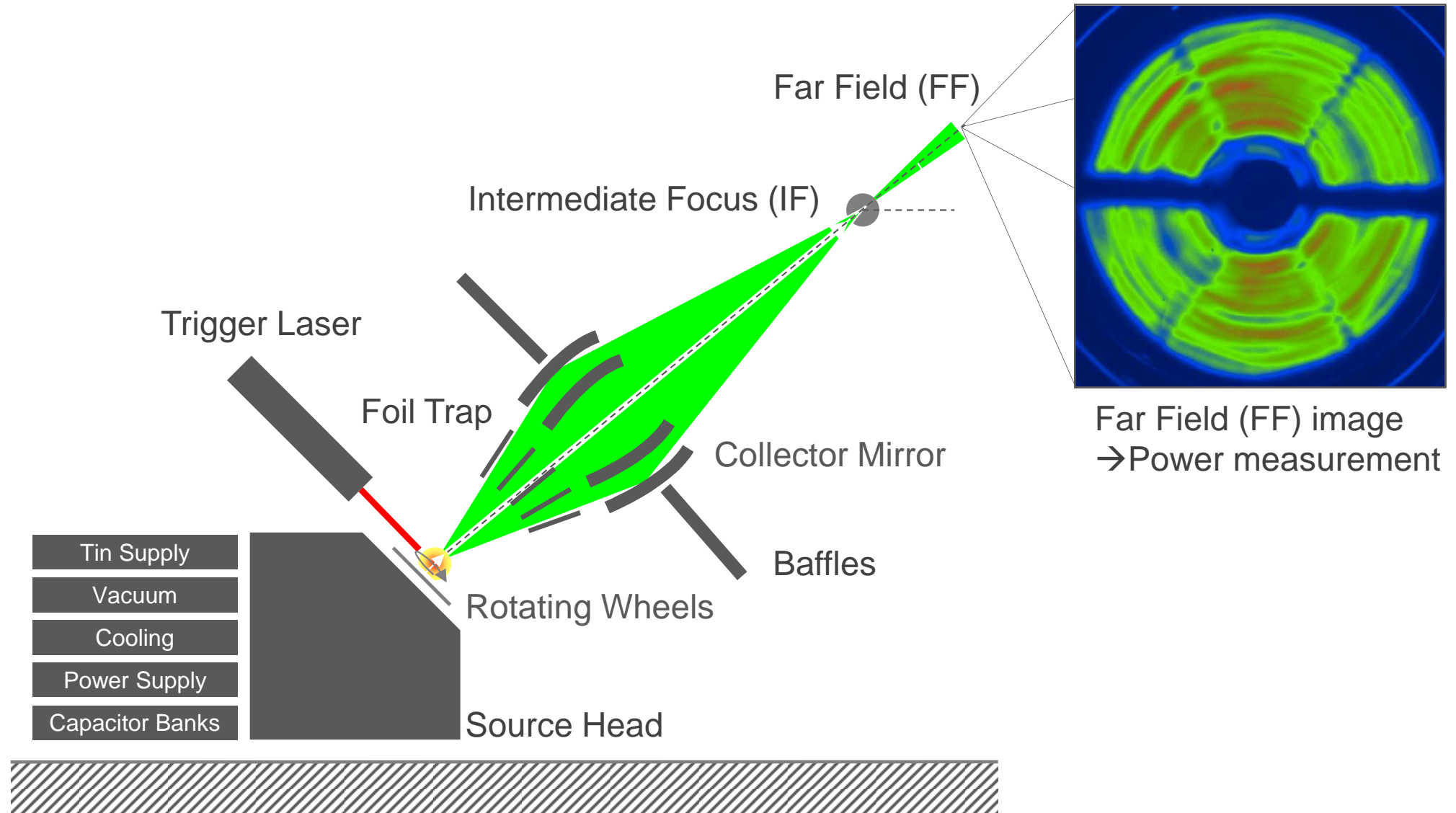
XTREME's LDP* Concepts – A Quick Refresher

*Laser assisted Discharge Plasma

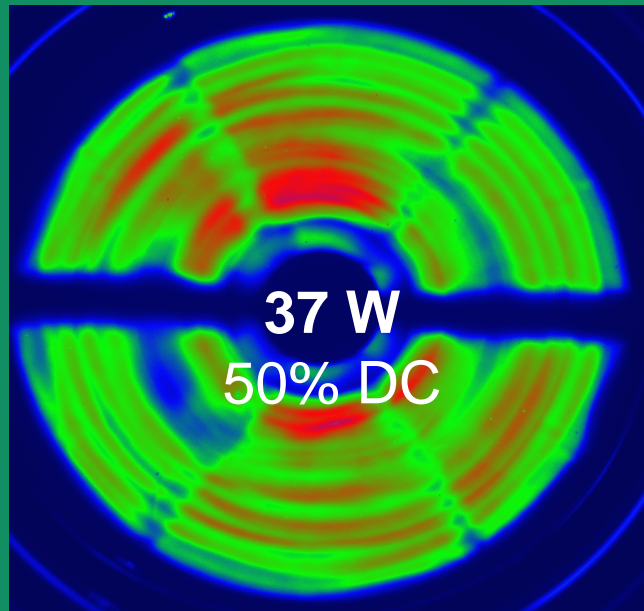
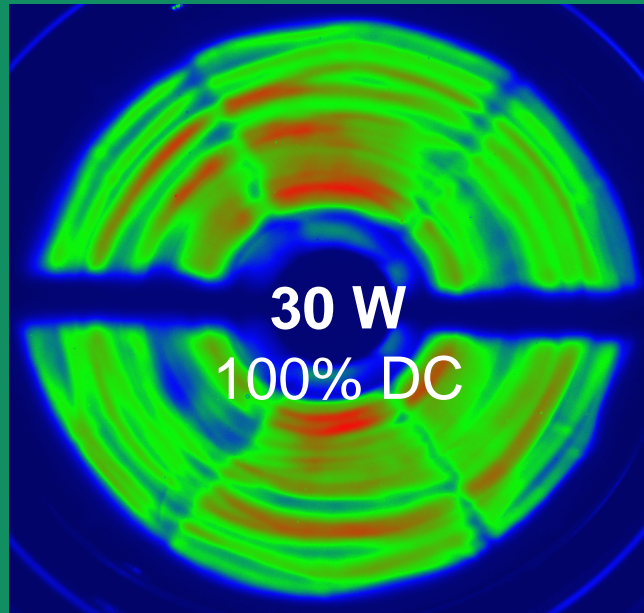


XTREME's LDP* Concepts – A Quick Refresher

*Laser assisted Discharge Plasma



Where Were We Last Year In Miami ?



- Far Field images 35cm after IF
- Power refers to power after IF
- Power was actually measured after IF aperture
 - Not calculated from plasma power

Will EUVL Ever Be A Reality ?

- Will EUV light sources ever scale ?
- Could EUV light sources be turned into a product ?
- Do we have our priorities right ?
- Conclusions

USHIO
G R O U P

Will EUVL Ever Be A Reality ?

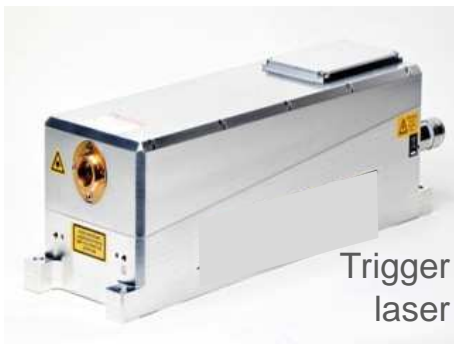
- Will EUV light sources ever scale ?
- Could EUV light sources be turned into a product ?
- Do we have our priorities right ?
- Conclusions

USHIO
G R O U P

Could Physics Be Integrated Into A **Viable Technology** ?

- Last July, XTREME has resumed power scaling experiments on Ushio 3 integrated system to investigate short term scalability

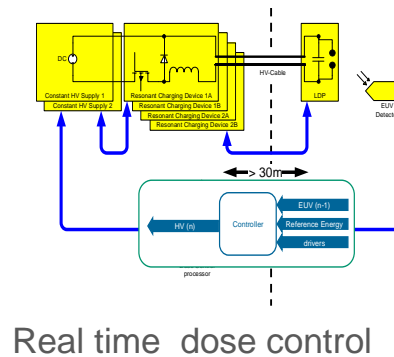
Laser Engineering



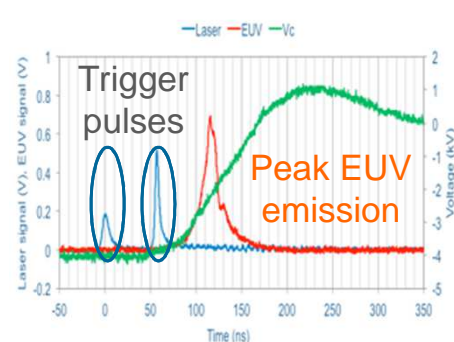
Tin Flow Engineering



Control Engineering



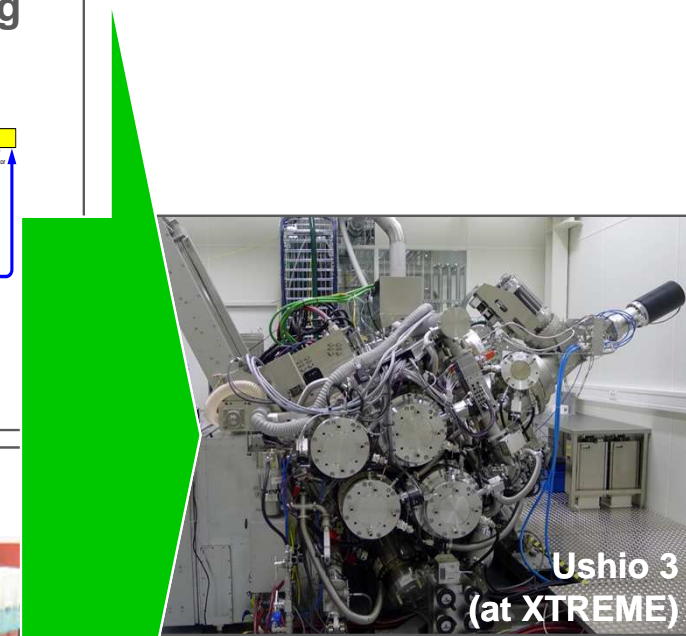
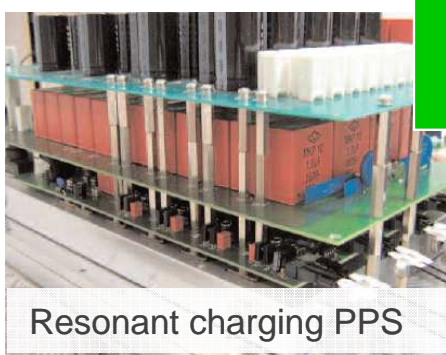
Plasma Engineering



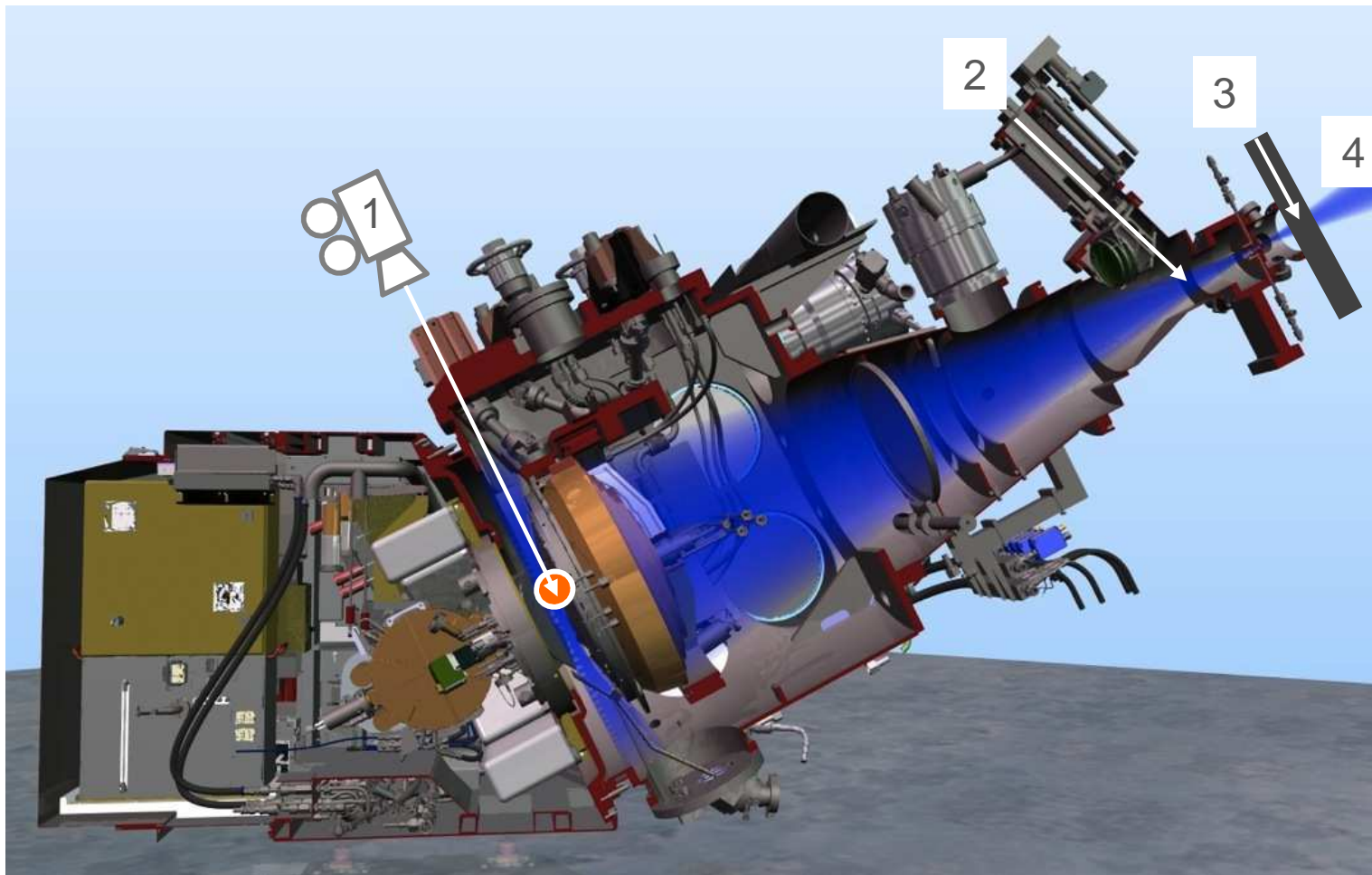
Thermal Engineering



HVPS Engineering



Measuring Collectable EUV Power



1 - At plasma
collectable in-band power with pinch camera calibrated energy monitor

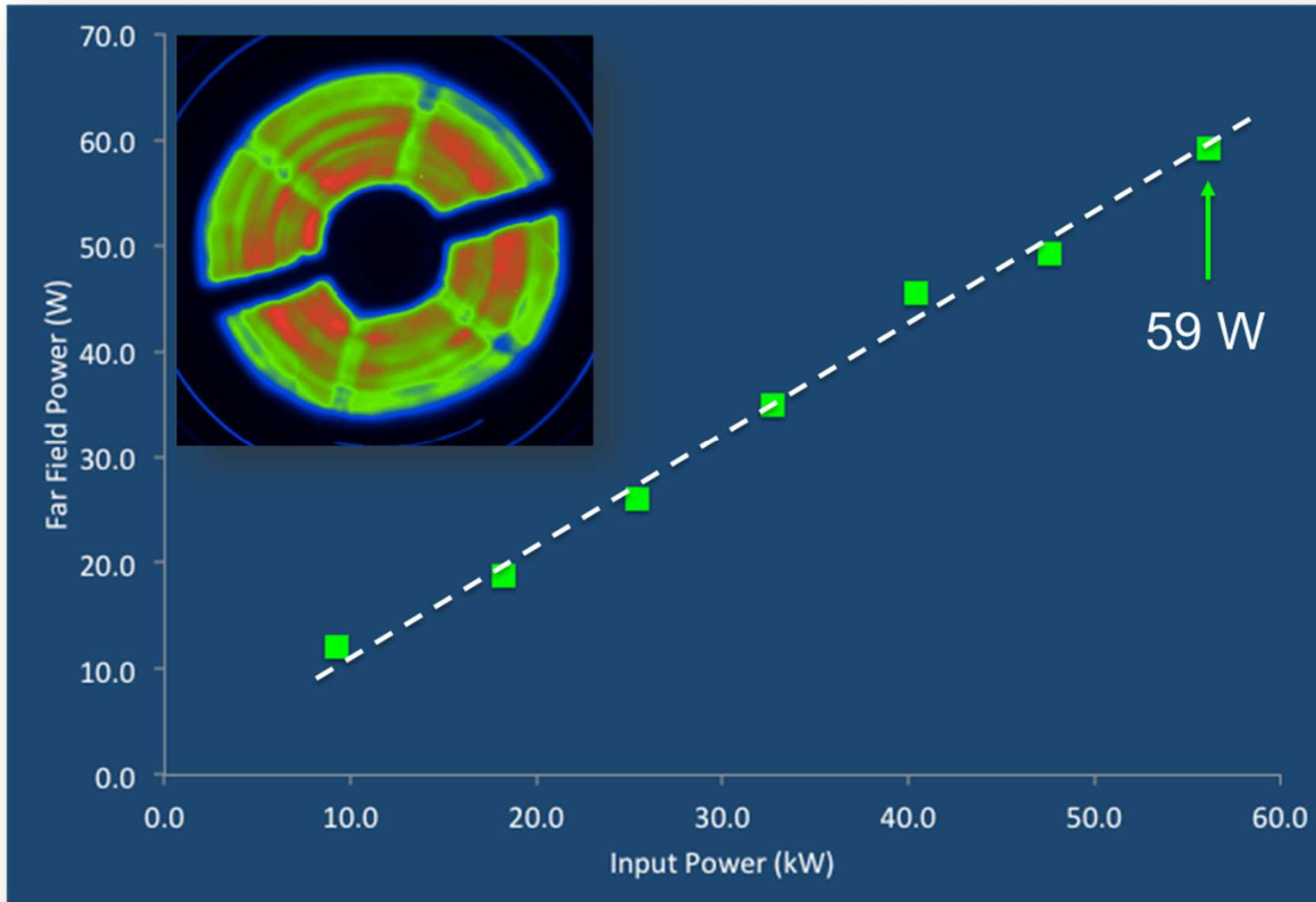
2 - Before IF
NFST camera can be moved in the EUV beam

3 - Behind IF
FFST (external sensor – XTREME only)

4 – Inside scanner
Energy Sensor at reticle level

Since Miami ...

- In July, 59 W after IF was achieved

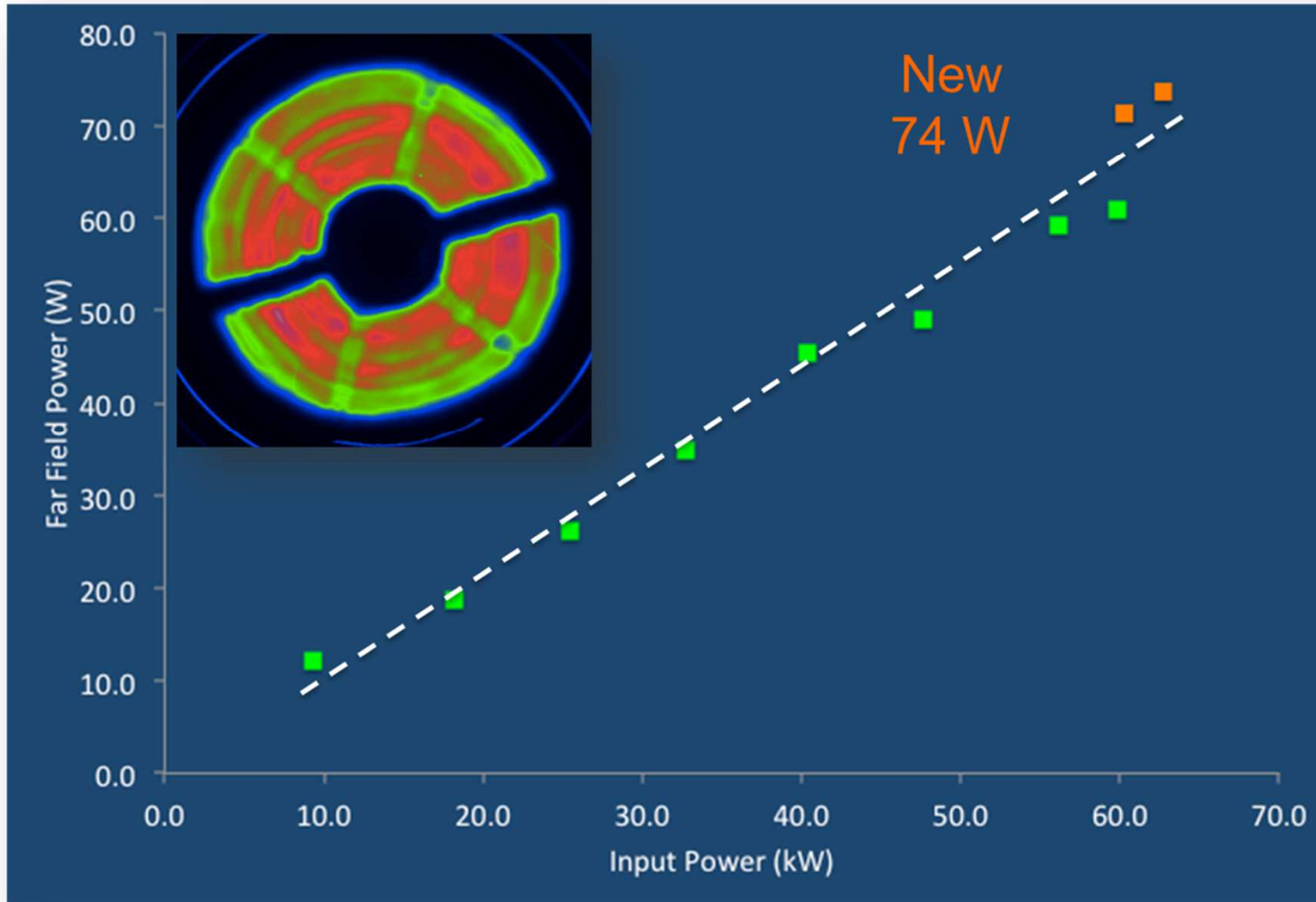


Excellent linearity
was achieved

Burst mode
200 ms

Just In:

New Record 74 W After IF



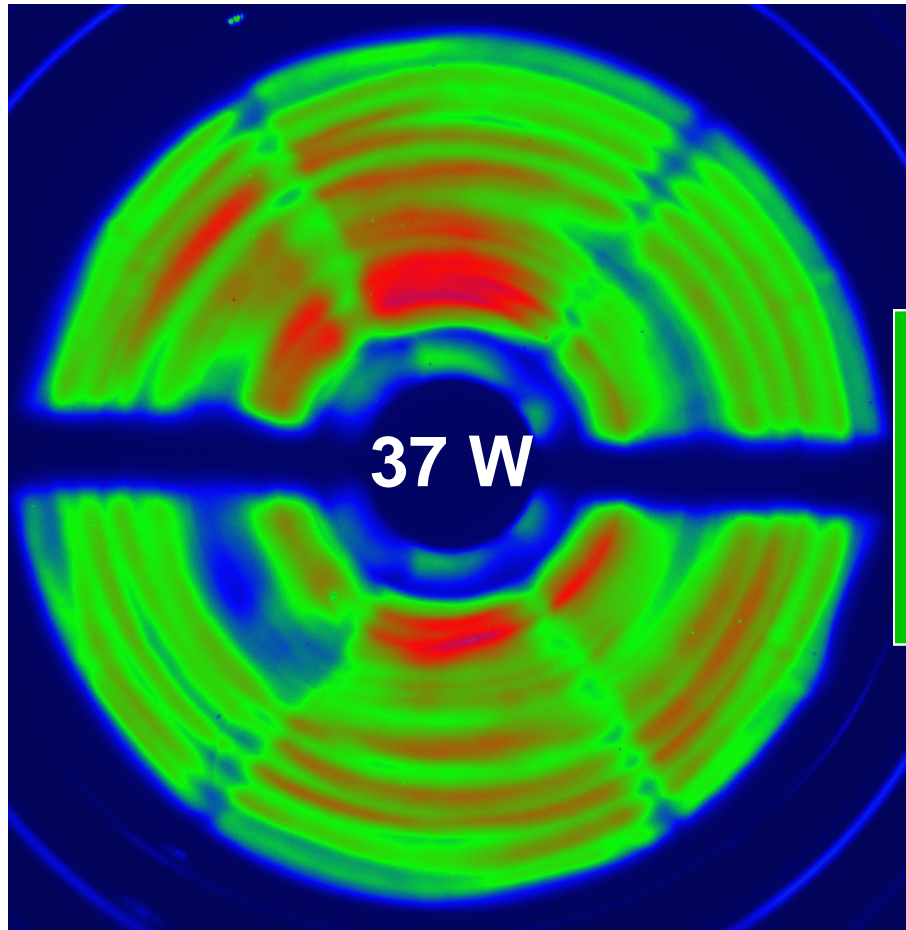
Burst mode
200 ms / 12% DC

Pulse energy
3-4 J

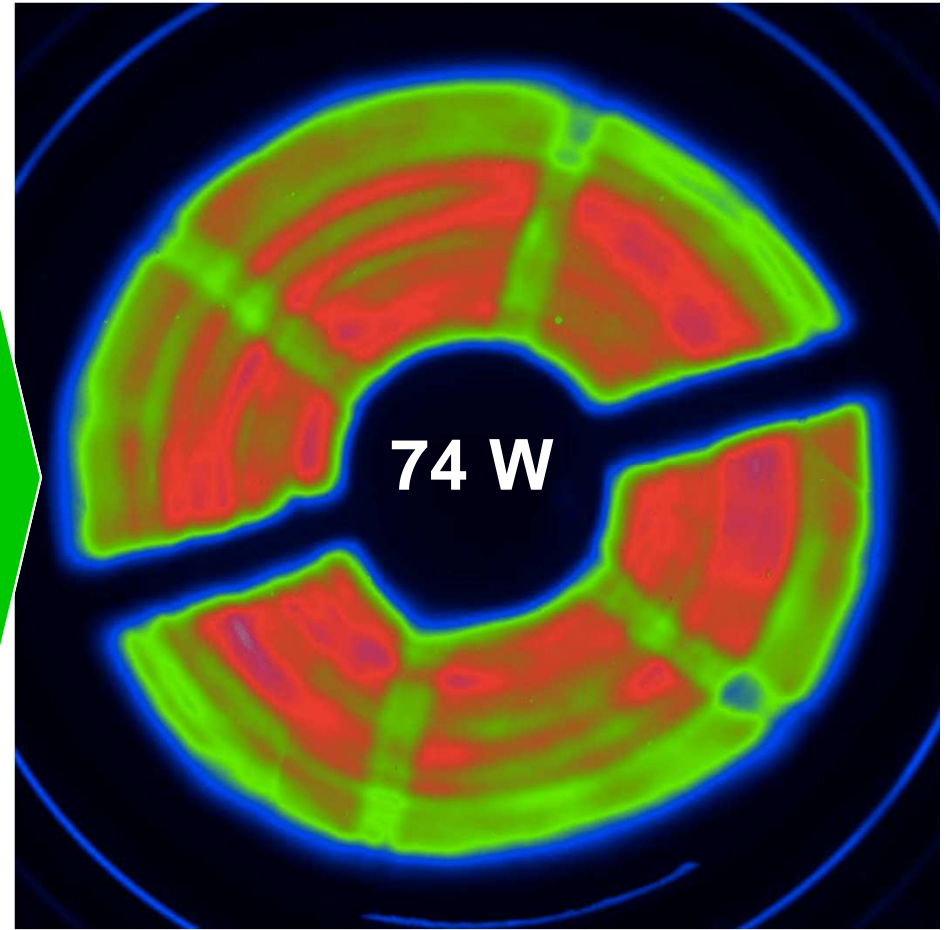
1 hour run at 74W

LDP Has Made Steady Progresses

Last year in Miami



This year in Brussels

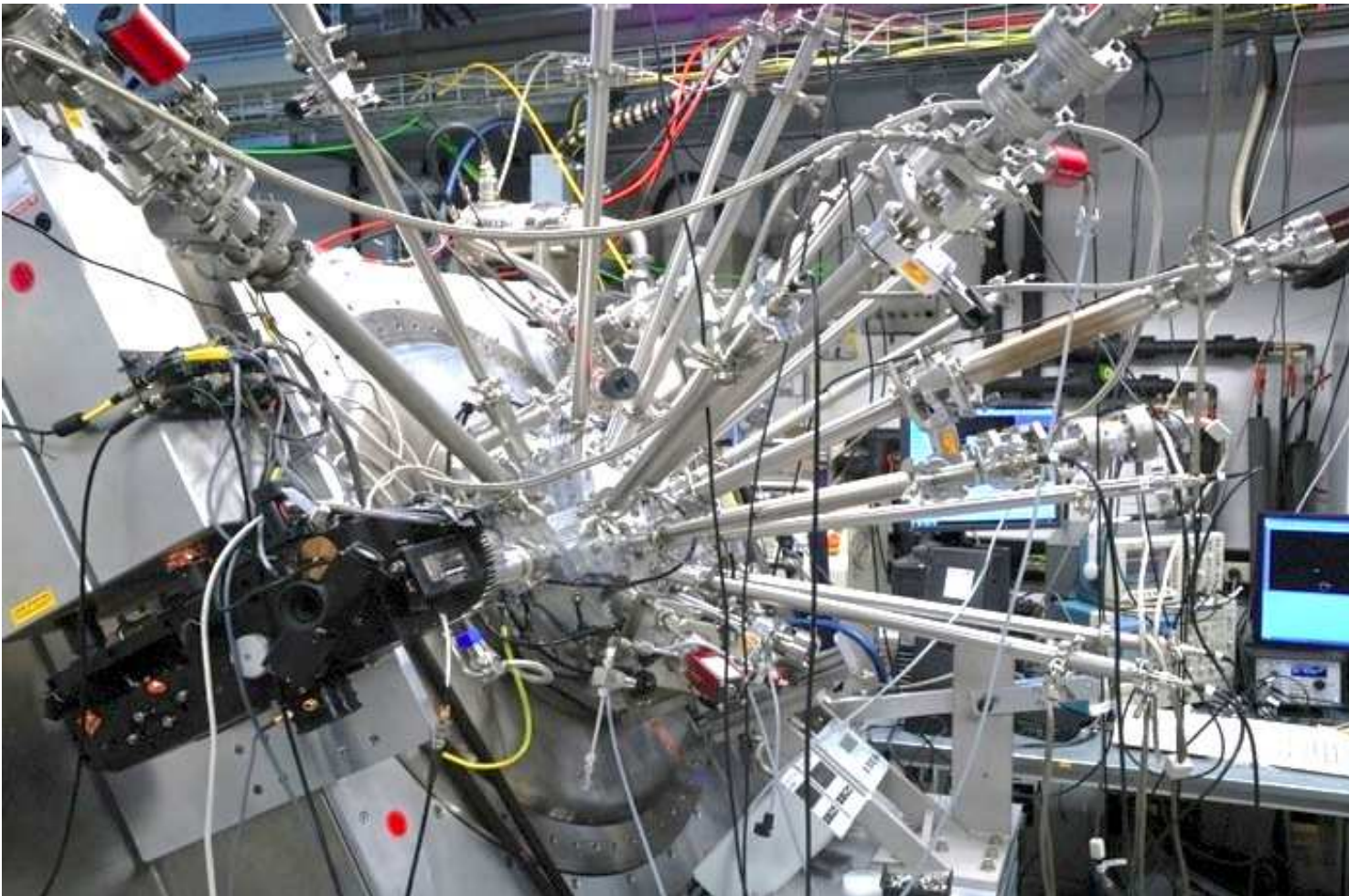


Integrated source Ushio 3
Burst mode

Could Physics Be Integrated Into A **Viab**le Technology ?

Could LDP Scale Beyond 250 W ?

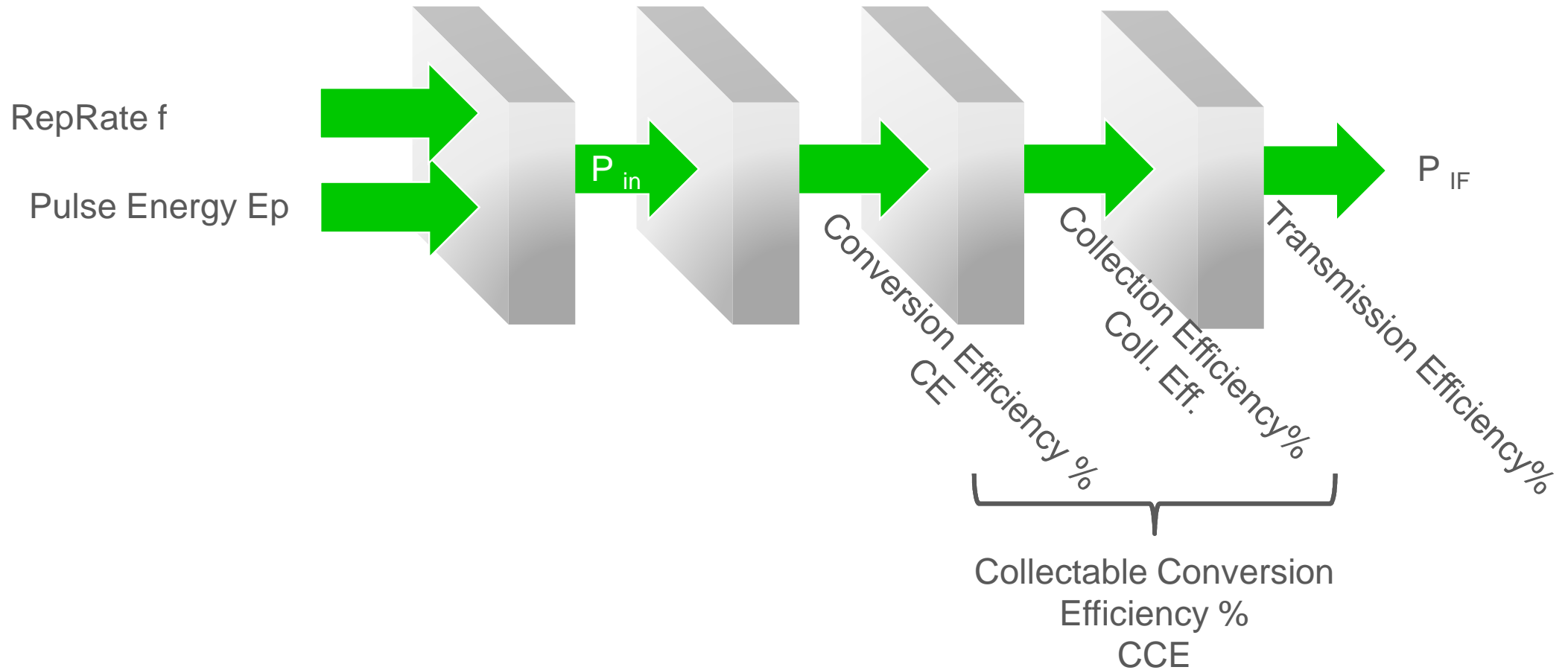
- Why would anyone pursue a given technological path if it does not scale in the long term ?
 - A test stand (Obelix II) has been specially built to allow XTREME to validate LDP long term scalability



Power scalability:

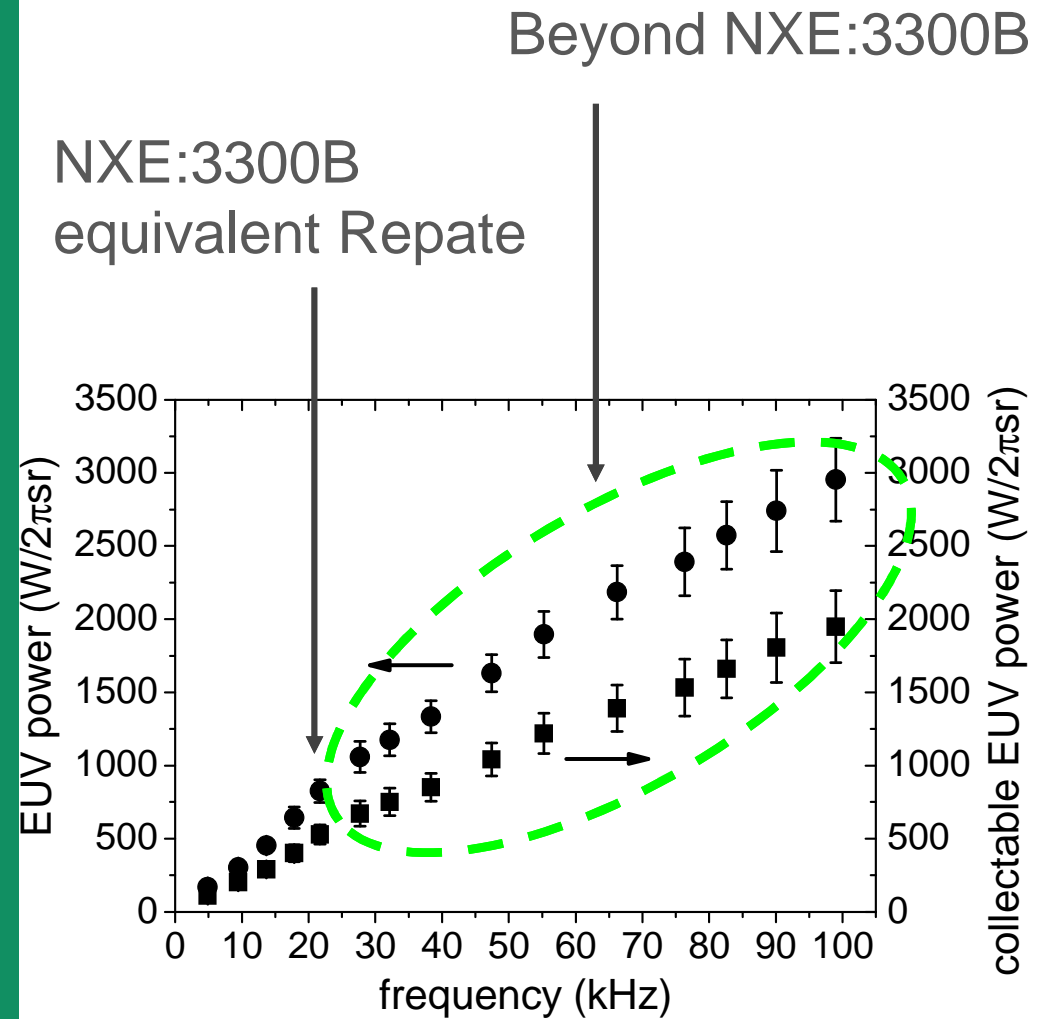
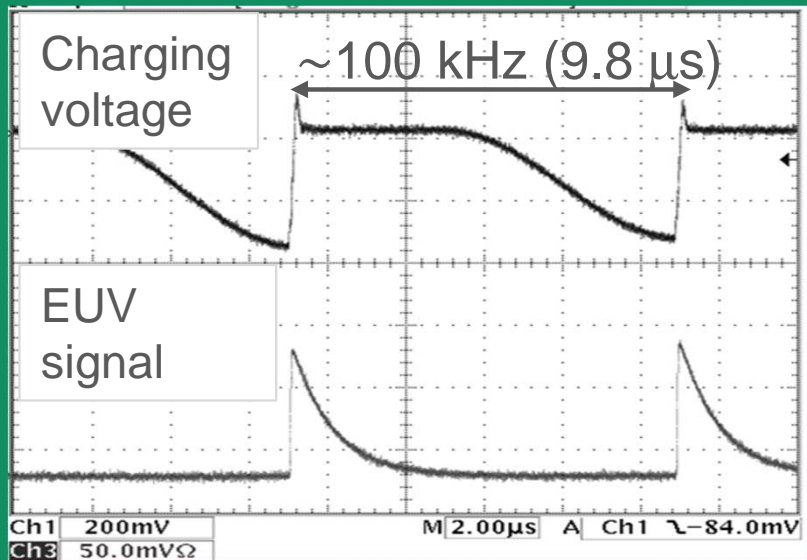
- Reprate scalability
- Pulse energy scalability
- Conversion efficiency optimization
- Collection efficiency optimization

First, What It Means To Scale LDP



LDP RepRate Scalability

- LDP's replate long term scalability is proven **BEYOND** the requirements for 3300B (250W)
 - Interlaced low energy pulses experiments

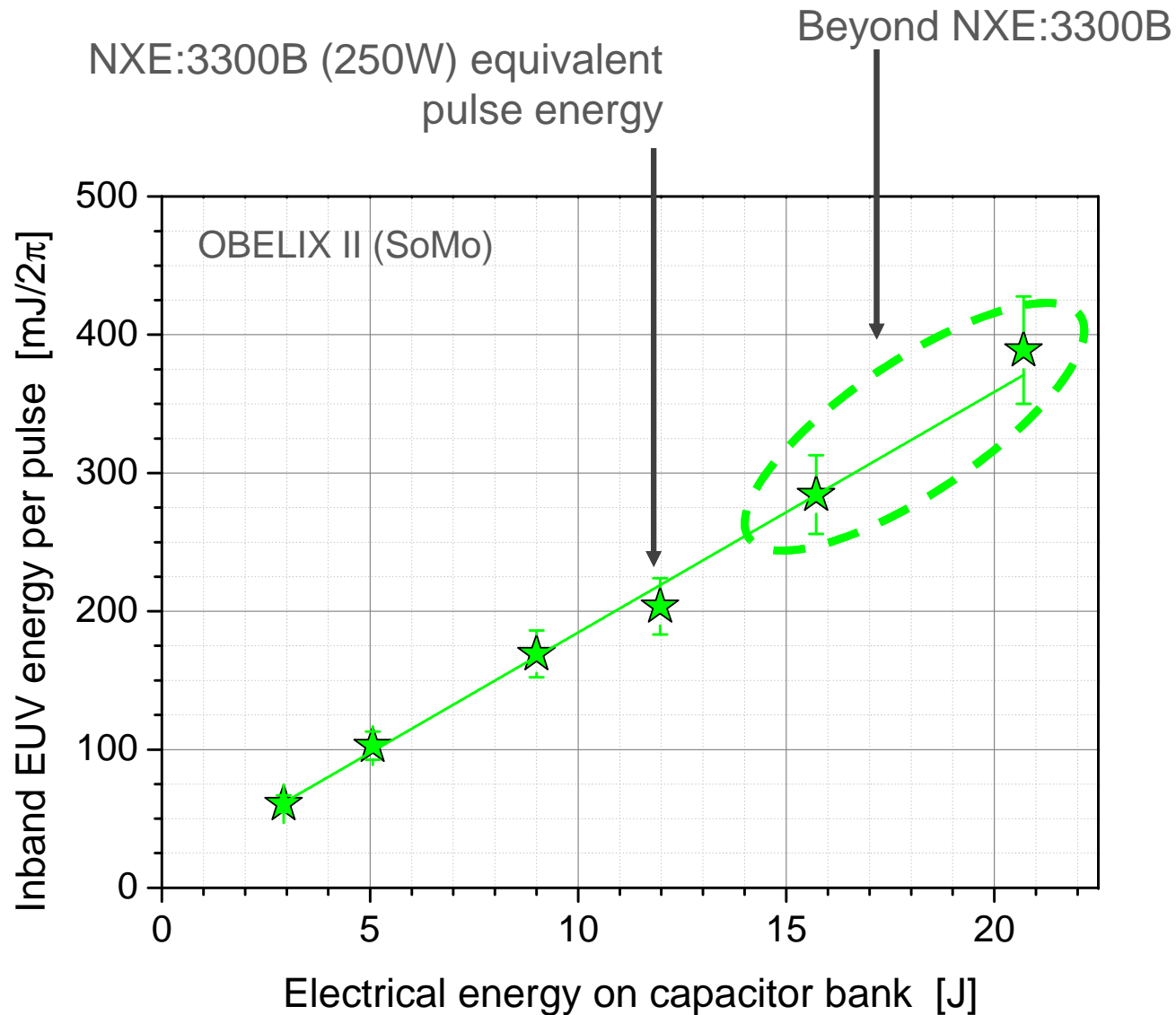


Experiment

Frequency = $1/(\Delta T \text{ between pulse 1 and 2})$

LDP Pulse Energy Scalability

- LDP's long term pulse energy scalability is proven **BEYOND** the requirements for NXE:3300B (250W)

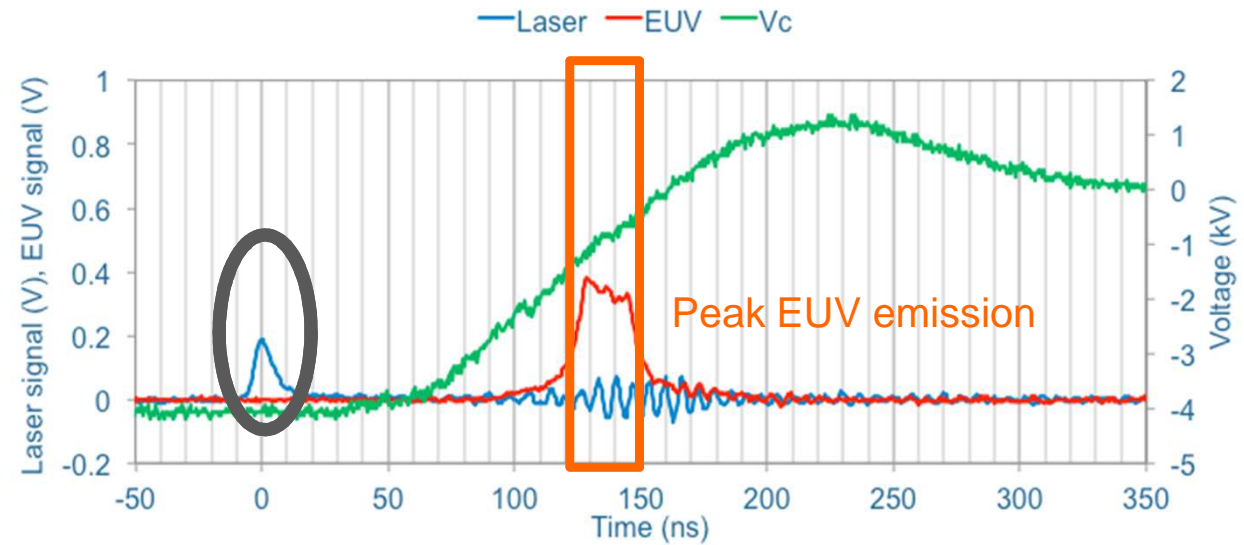


Please visit Poster
P-SO-05
Felix Kuepper,
Fraunhofer ILT

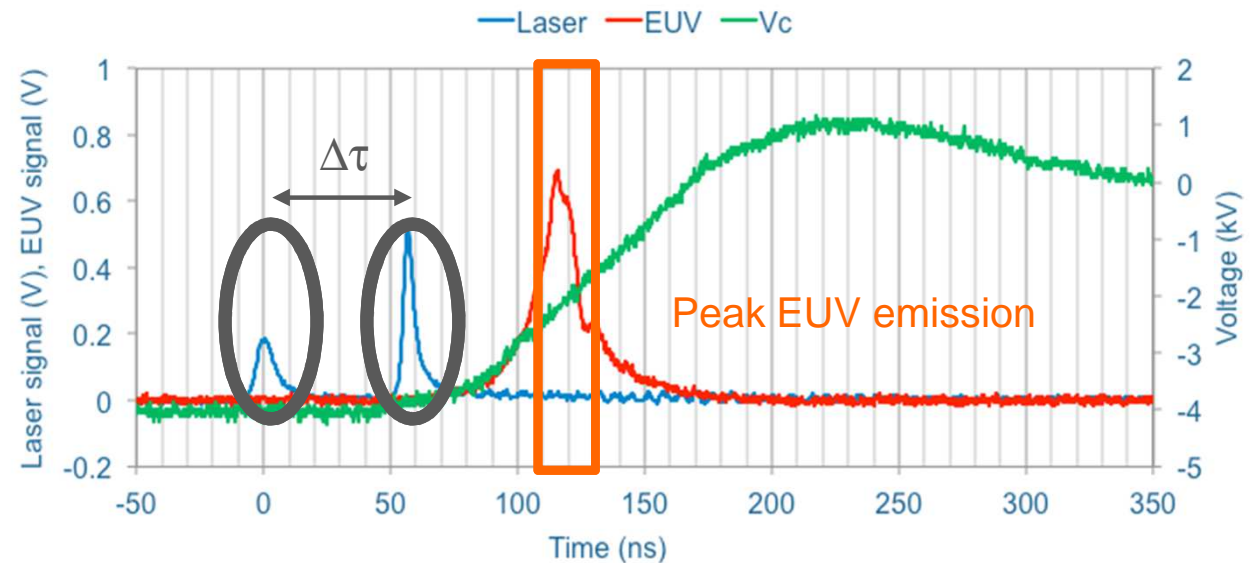
Plasma Engineering

- Tailoring the laser pulse train allows XTREME to engineer the plasma emission

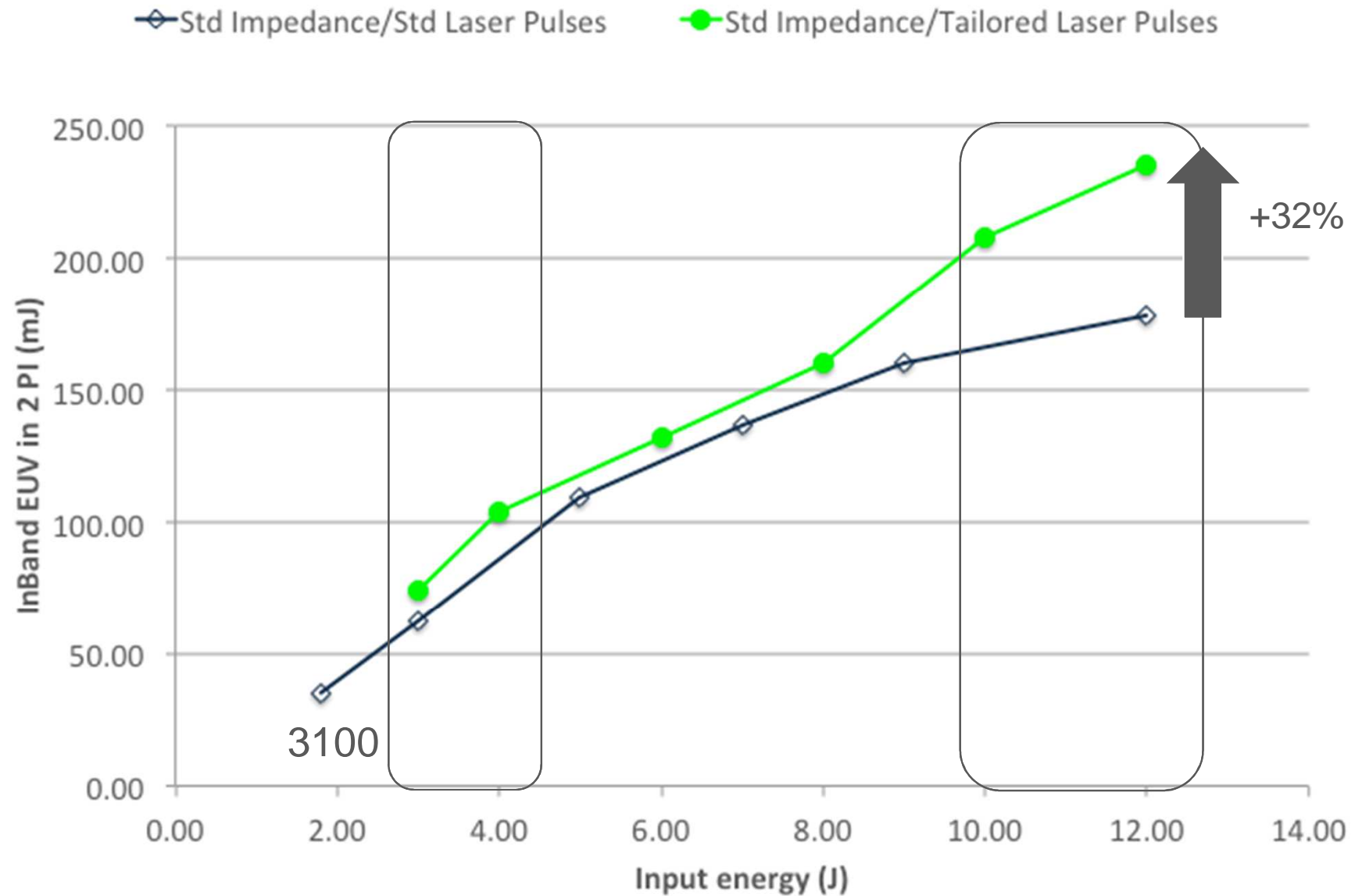
Single trigger laser pulse



Double trigger laser pulse

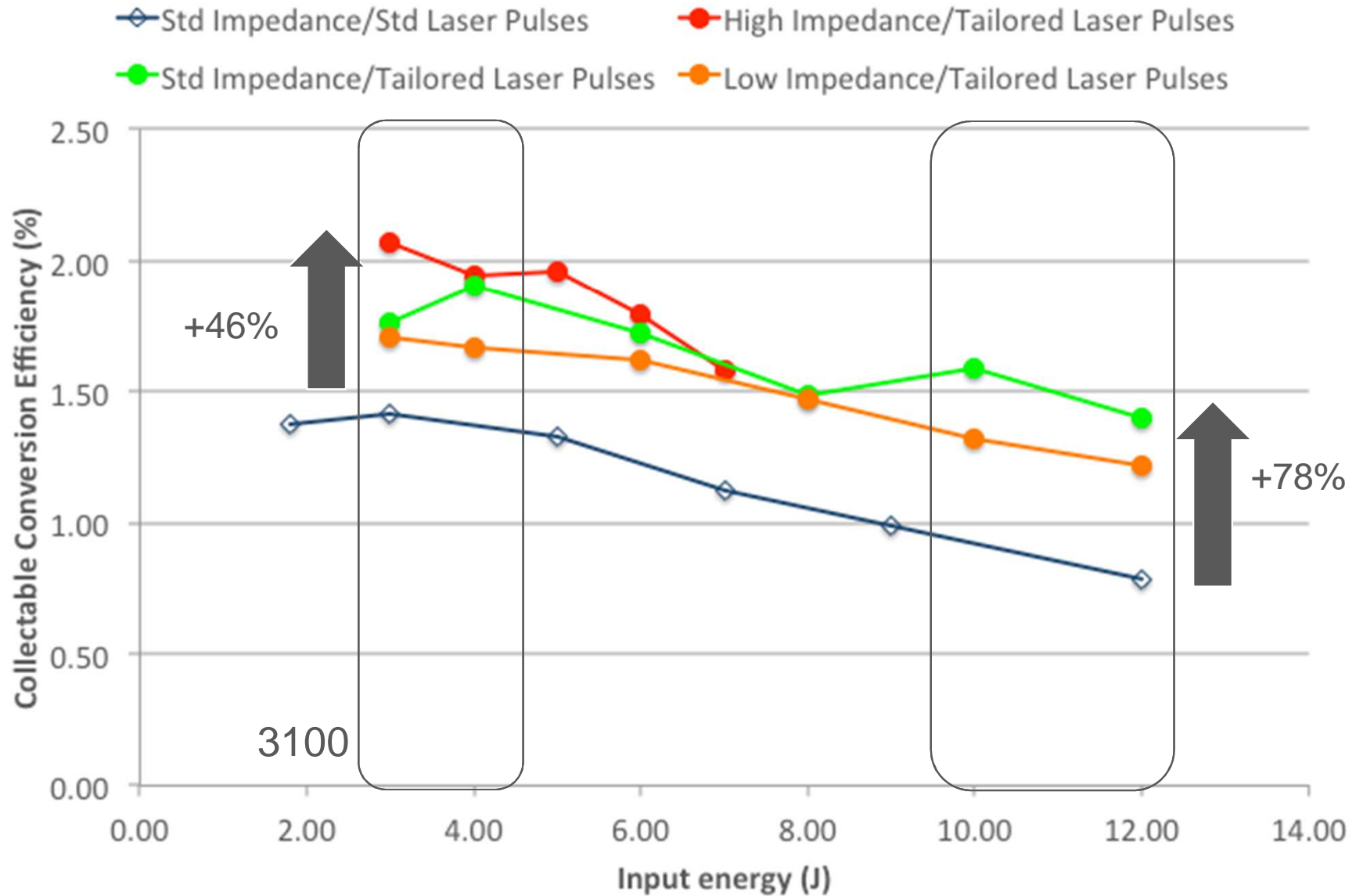


Engineering Pulse Energy With Lasers



Engineering Collectable Conversion Efficiency

- CCE (Collect. Conv. Eff.) = Conversion Efficiency x Collection Efficiency



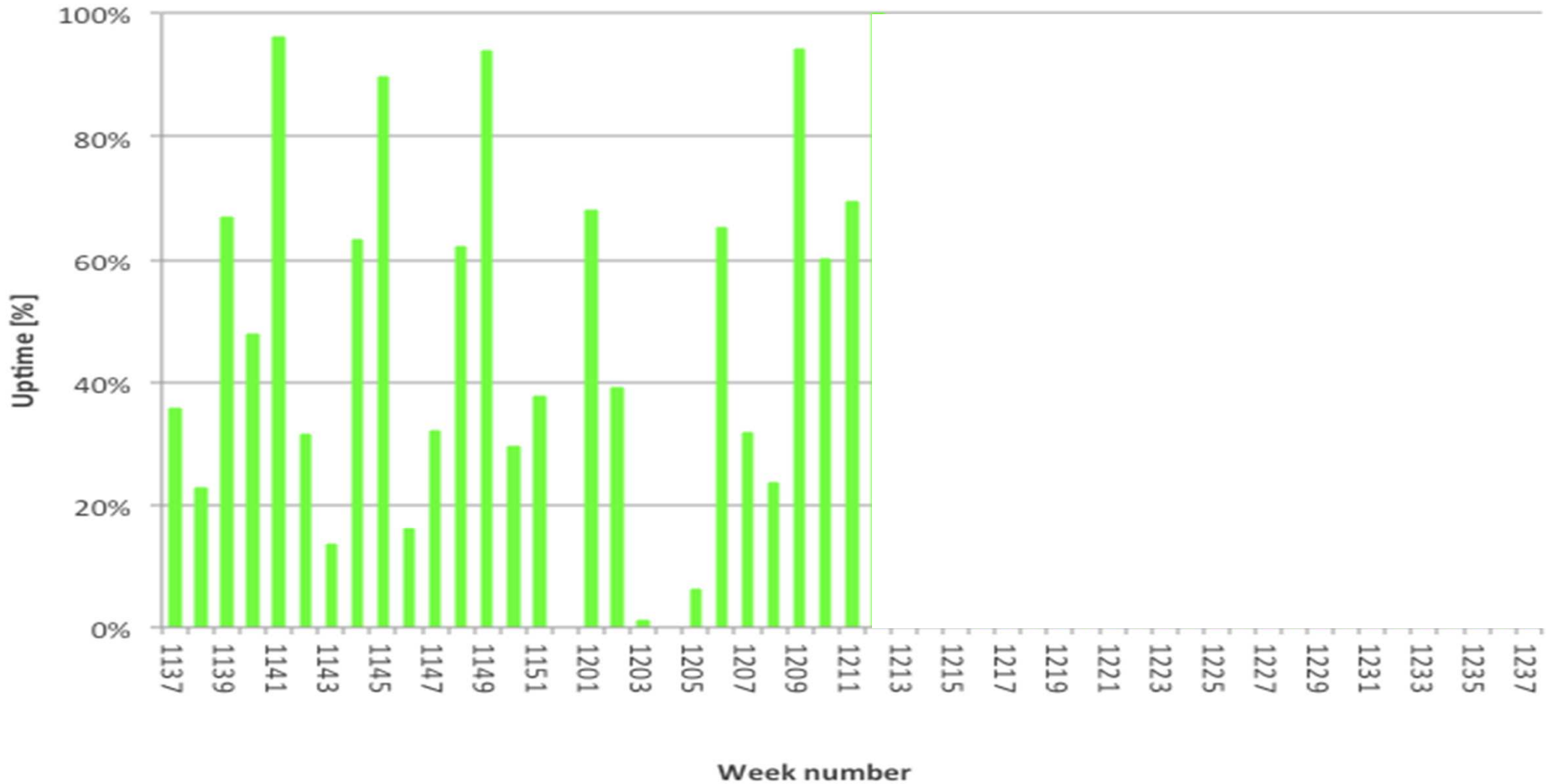
Will EUVL Ever Be A Reality ?

- Will EUV light sources ever scale ?
- Could EUV light sources be turned into a product ?
- Do we have our priorities right ?
- Conclusions

USHIO
G R O U P

The Not So Long Ago **Early Days Were Painful**

- Ushio 1 source at IMEC initial availability was very disappointing



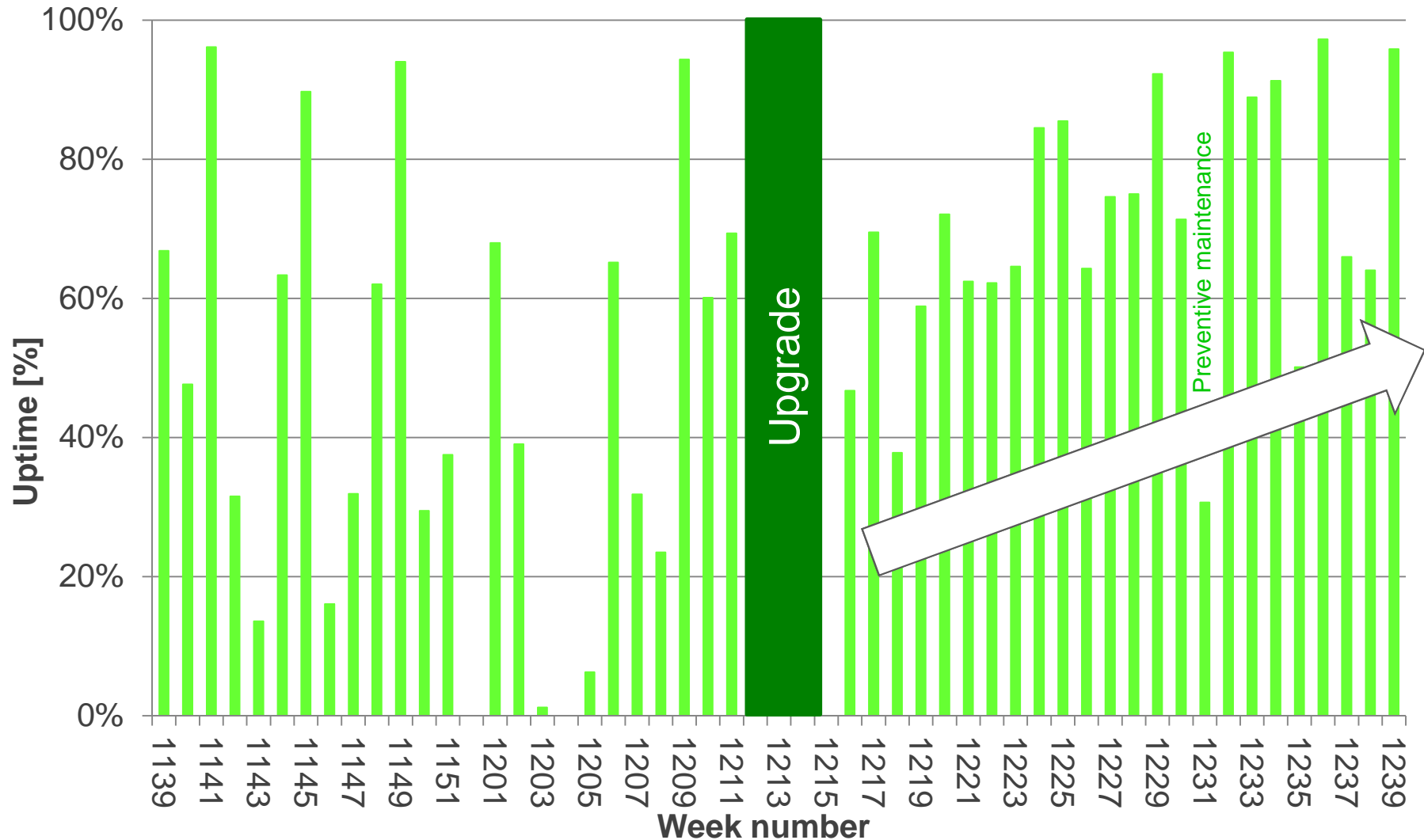
Turning **Technology** Into A Product

- To stabilize the technology, over H1 2012, XTREME reallocated resources, launched a major re-design effort and upgraded Ushio 1



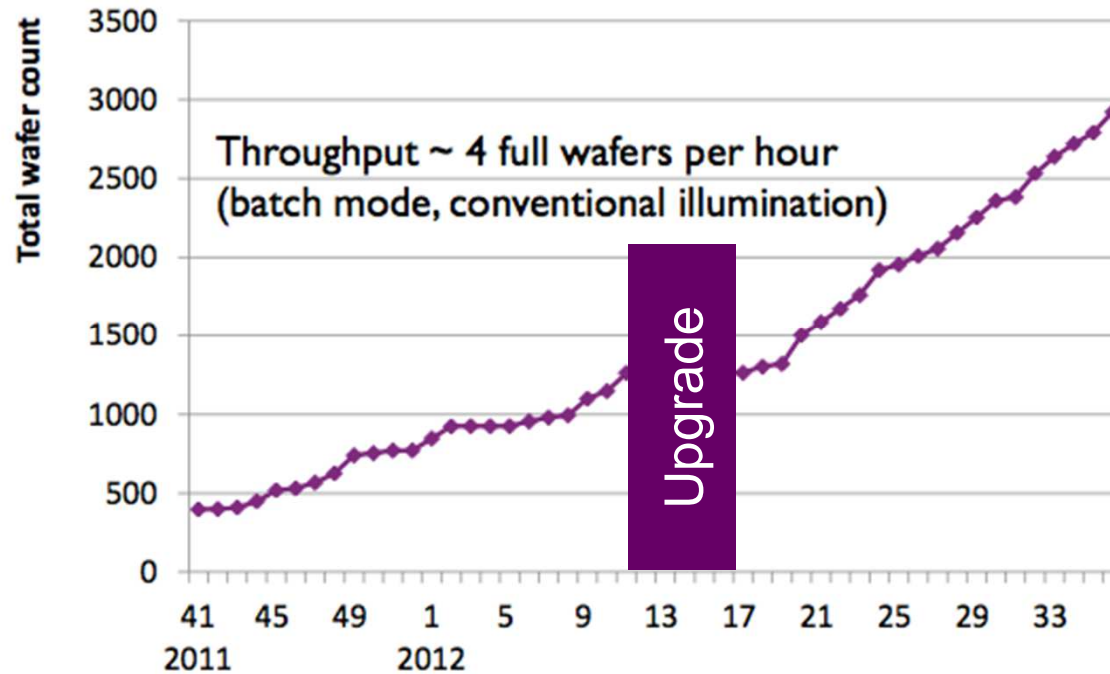
After Upgrade, Ushio 1 Uptime Has Steadily Increased ...

- Recently, uptime exceeds 90% (13 wk average now exceeds 75%)
- Volatility has also drastically decreased



... And Utilization (7x24) Is High

TOTAL NUMBER OF EXPOSED WAFERS NXE:3100 CUMULATIVE WAFERCOUNT

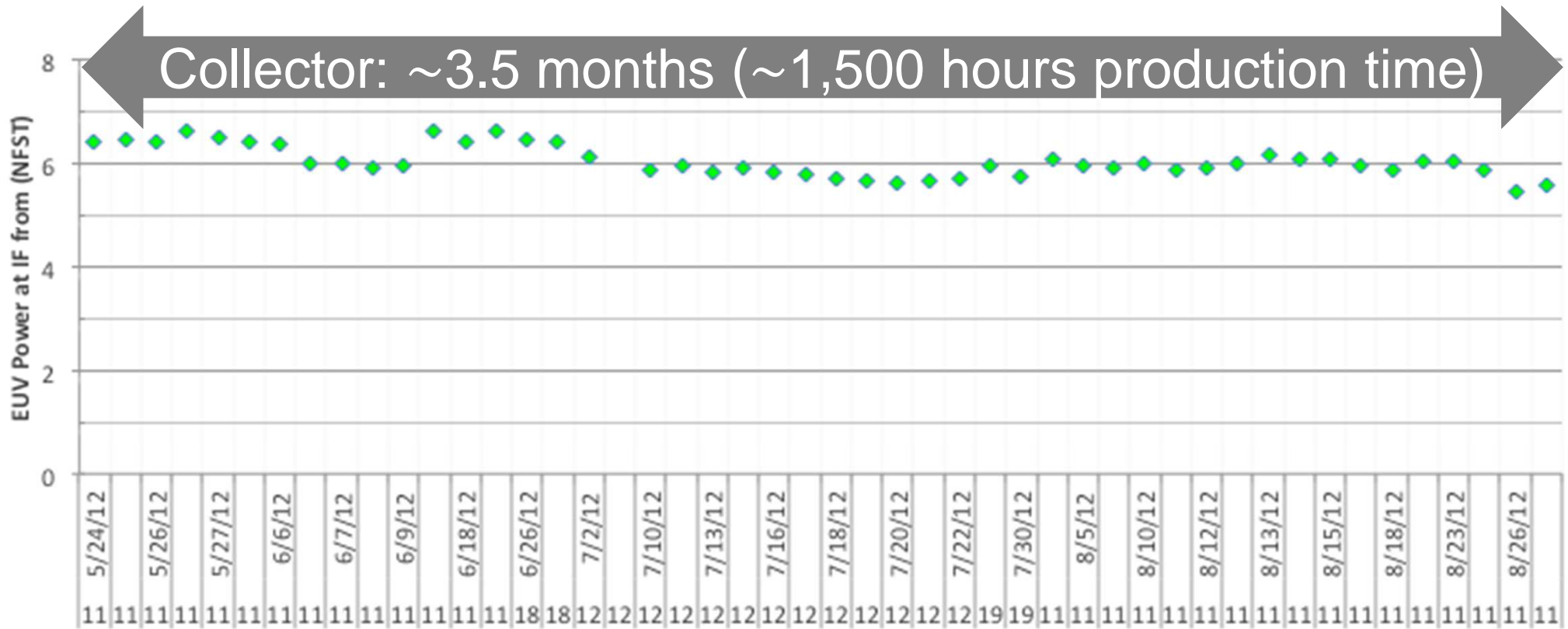


3,000 wafers have been printed so far

Cumulative wafercount now 3000 exposed wafers since tool installation – clear productivity increase since May 2012

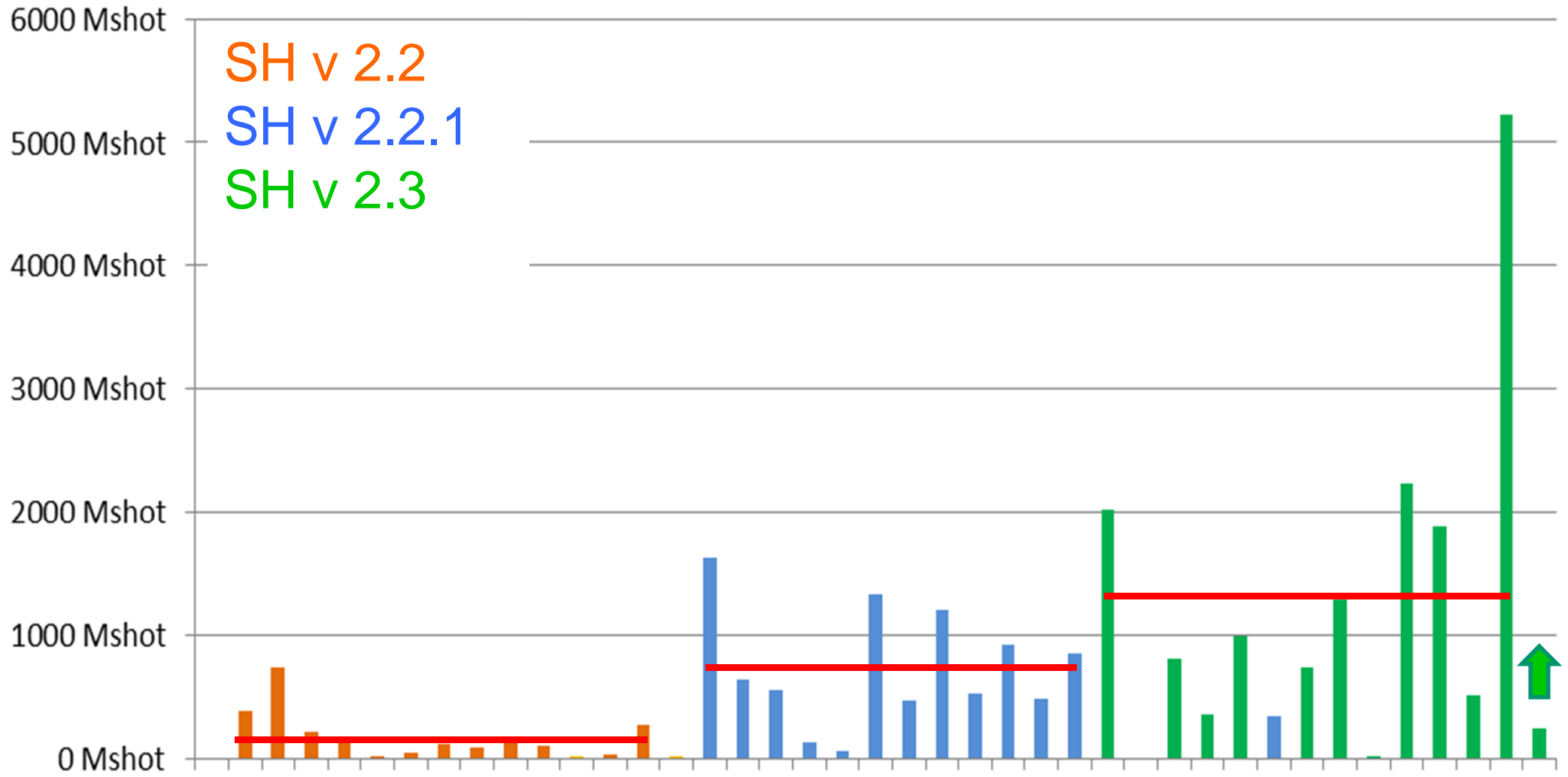
Long Collector Lifetime Is Achieved

- Power at IF is stable over the collector life



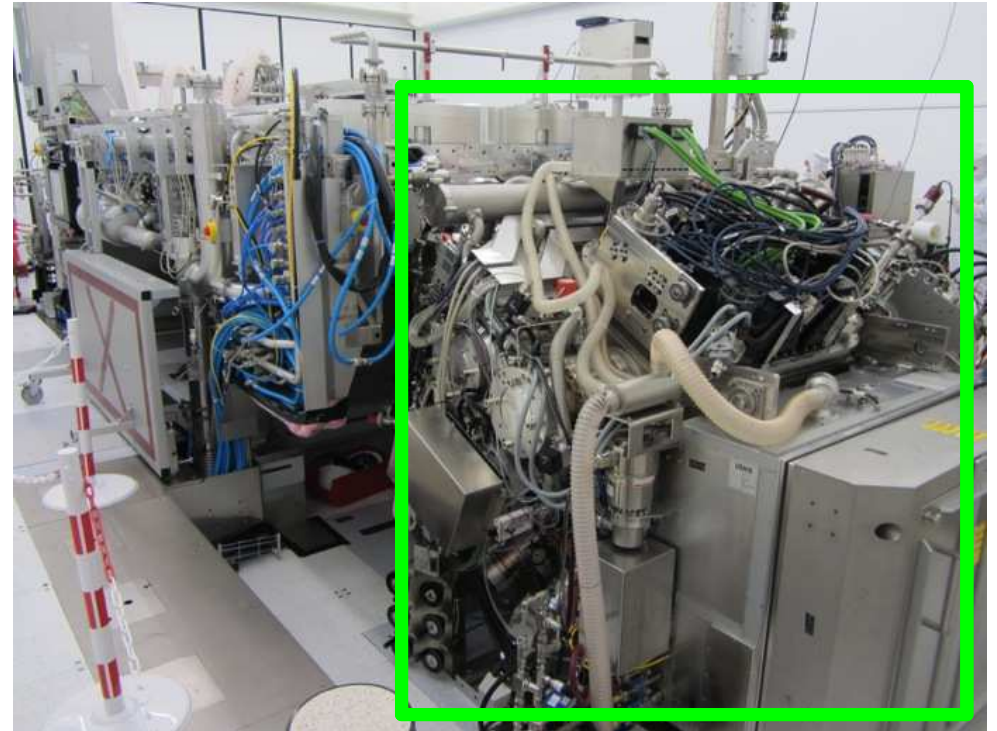
Lifetimes Have Increased

- Source Heads (SH) are no more the primary source of downtime



U2 & U4 @ ASML

- Ushio 2 & Ushio 4 light sources (3100) are integrated to NXE:3300B to support scanner development
- U2 (20 kW configuration) & U4 (50 kW configuration) are being upgraded as well
- U2 has now printed its first wafer



Will EUVL Ever Be A Reality ?

- Will EUV light sources ever scale ?
- Could EUV light sources be turned into a product ?
- Do we have our priorities right ?
- Conclusions

USHIO
G R O U P

Power, Power, Power !!! ... Simply More Power ?

POWER → THROUGHPUT
&
DOSE STABILITY → YIELD

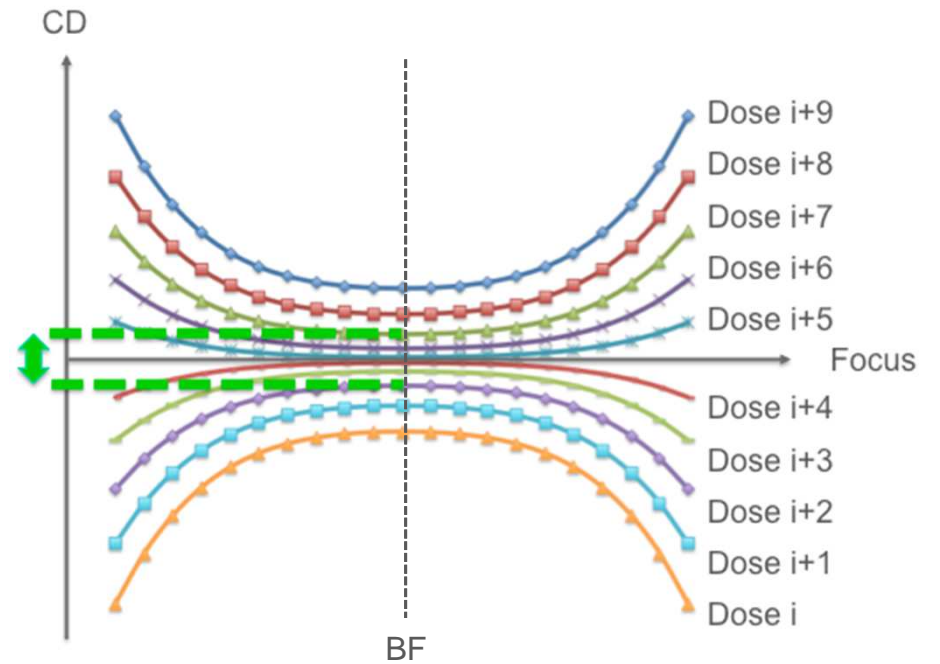
Can we really talk about
power **without talking about
dose stability**

?!?!?

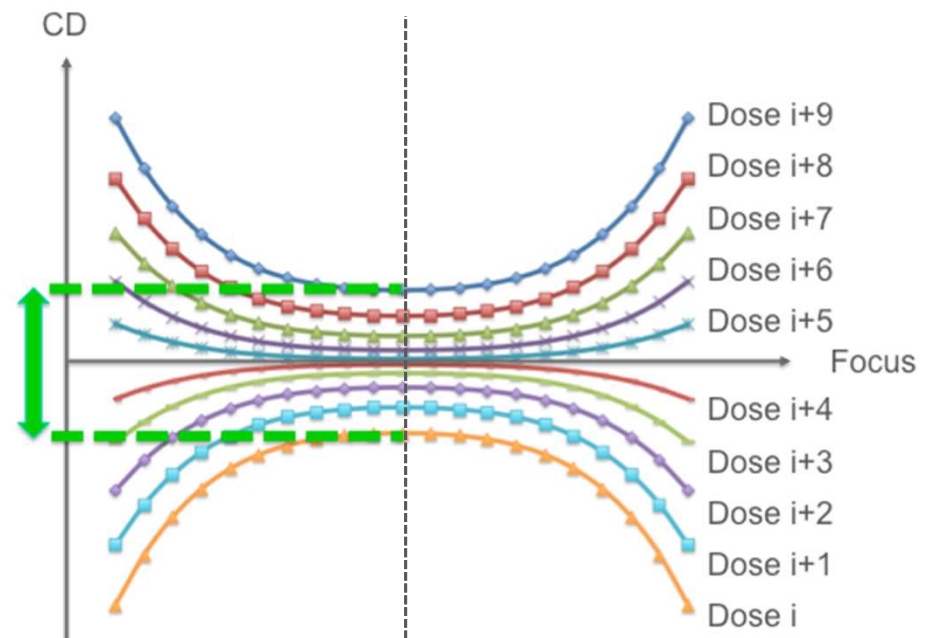
Why Does Dose Stability Matter ?

ASML dose specifications for EUV sources:
 $3\sigma < 0.2\%$

○ Small Δ Dose \rightarrow
Small Δ CD

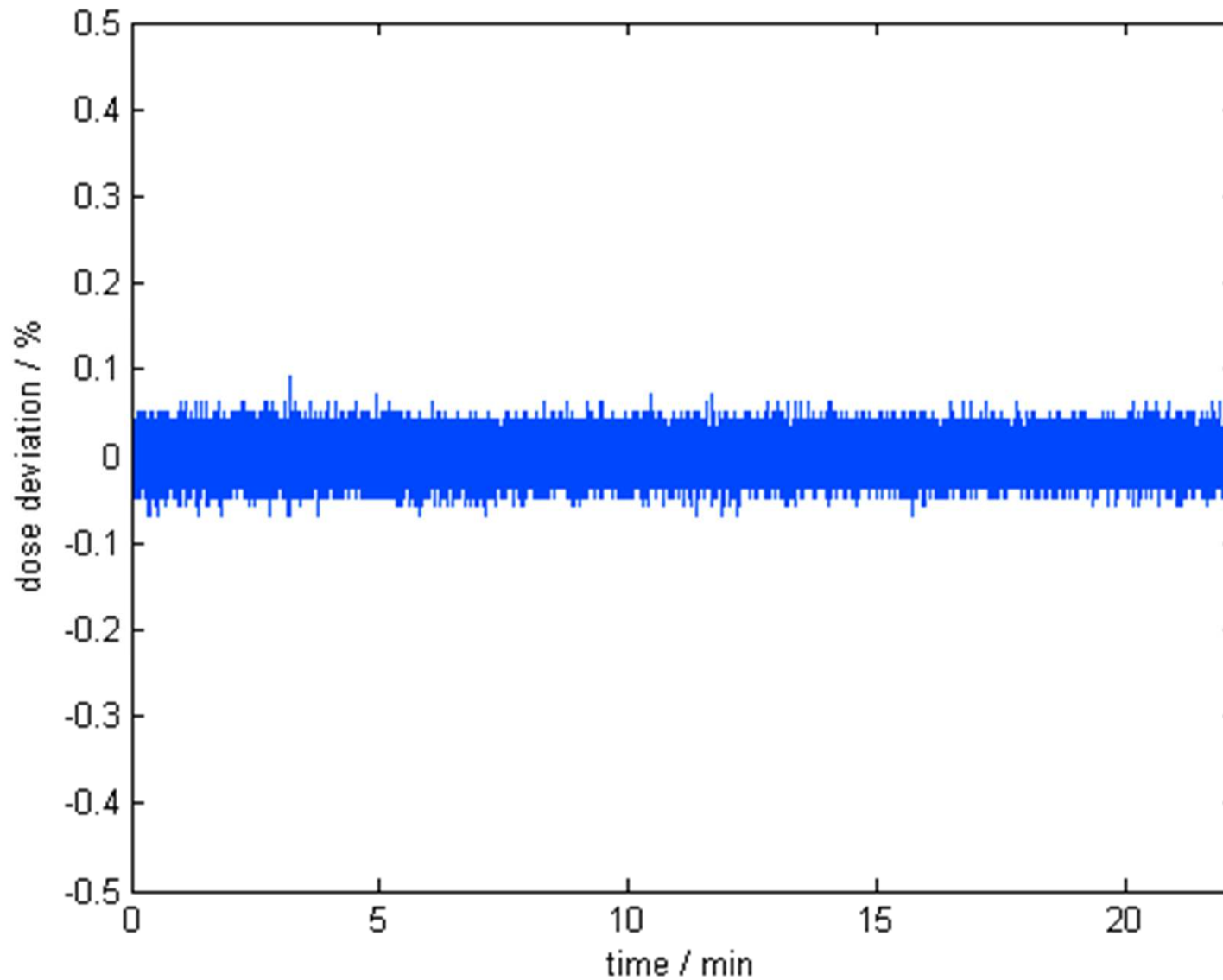


○ Large Δ Dose \rightarrow
Large Δ CD



LDP Dose Stability at 9kW

- Dose stability is $3\sigma < 0.1\%$
 - Specification: $3\sigma < 0.2\%$



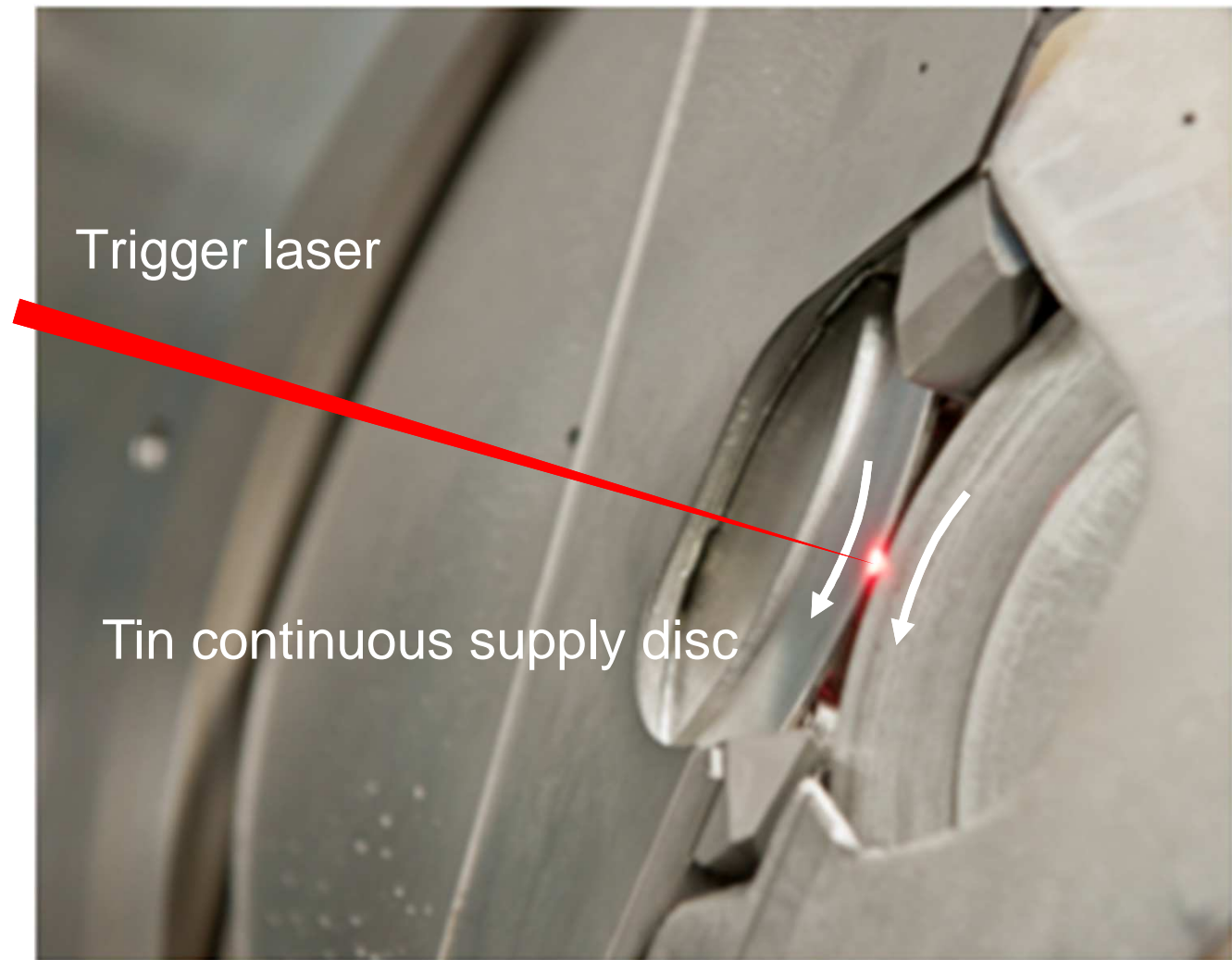
LDP Technology For HVM

How To Ensure Tight Dose Stability ?

LDP Stability = Continuous Tin Delivery

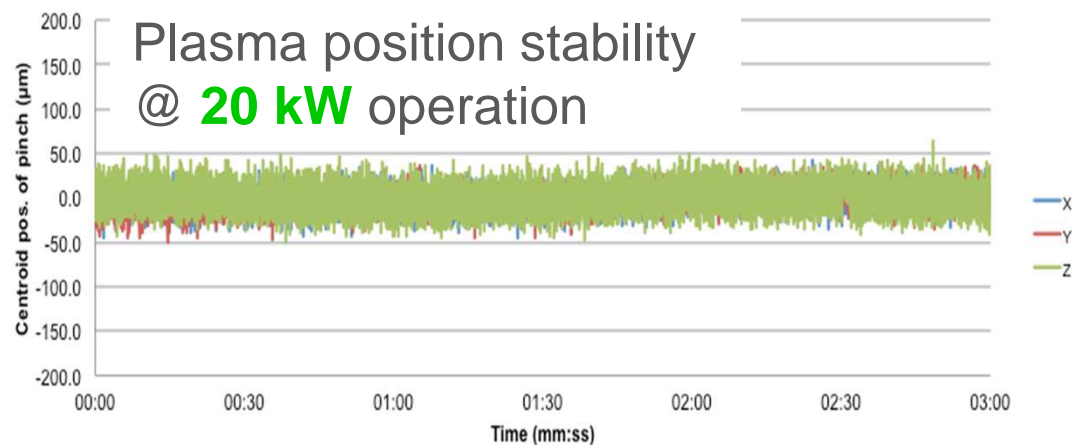
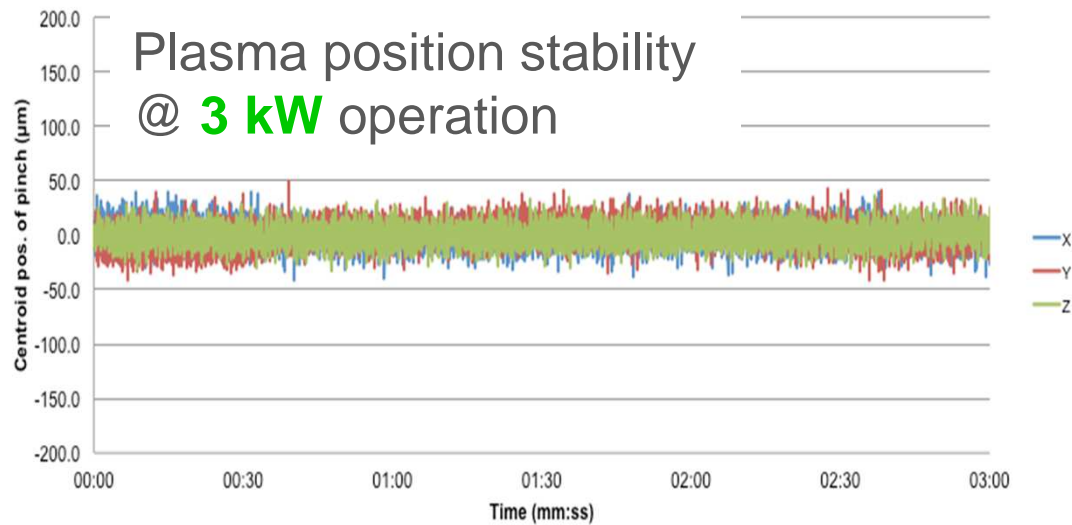
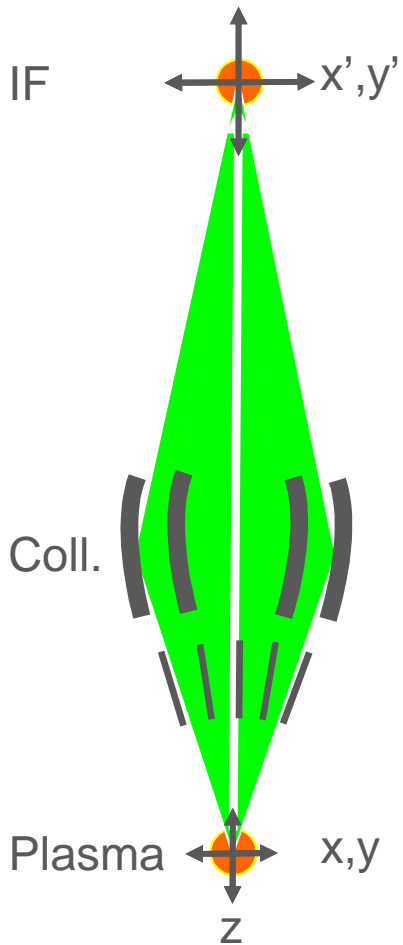
- Tin delivery is continuous

- No temporal discretization
- No missing target
- No missed pulse



LDP Stability = Plasma Position Stability

- Laser focus, Tin and plasma are always at the surface of the wheel
- Plasma position remains stable with power scaling



→ Stable laser focus

→ Stable plasma position

→ Stable Far Field image

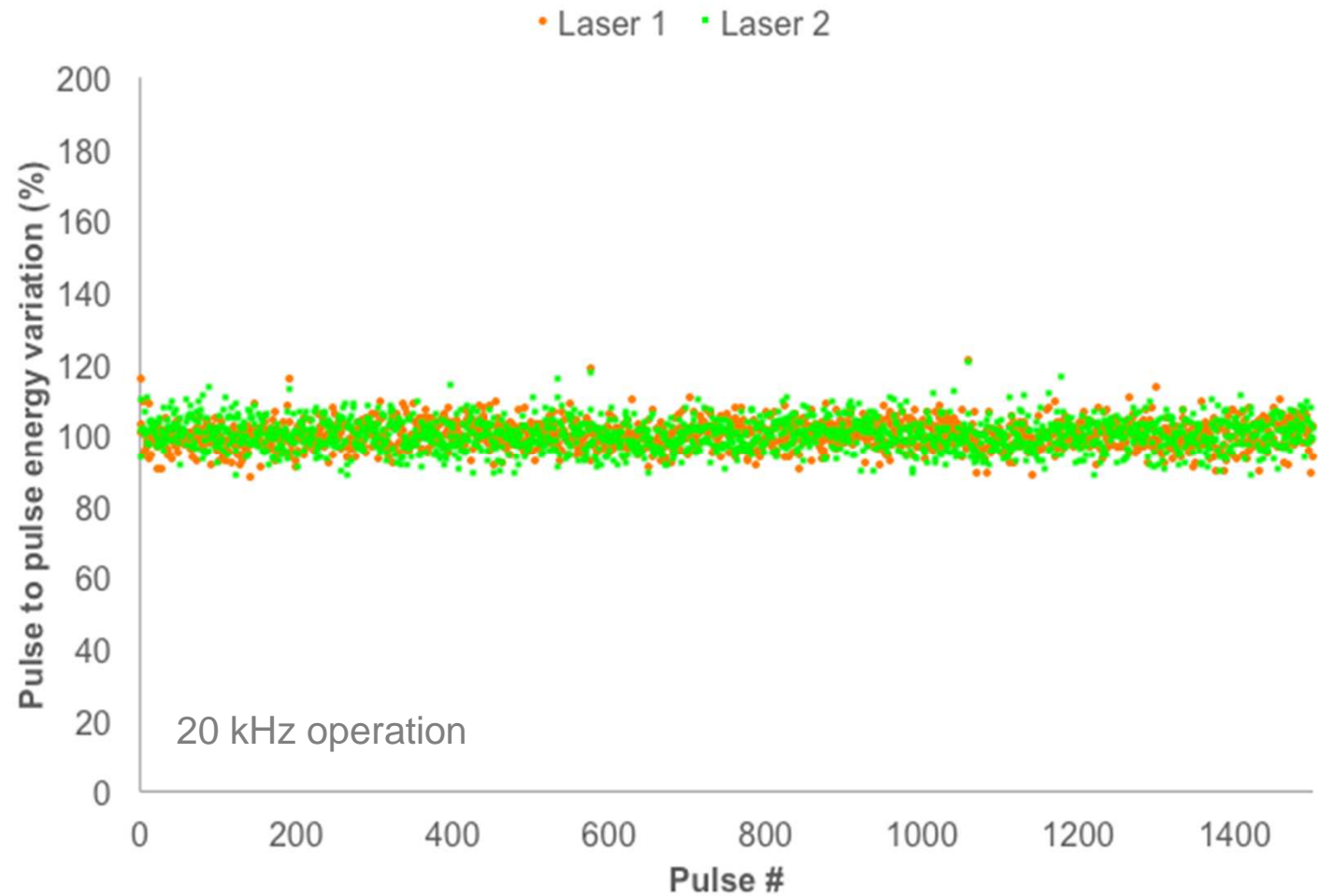
→ No dose variation caused by plasma position instability

LDP Stability = Trigger Laser Energy Stability

→ Trigger laser intensity stability

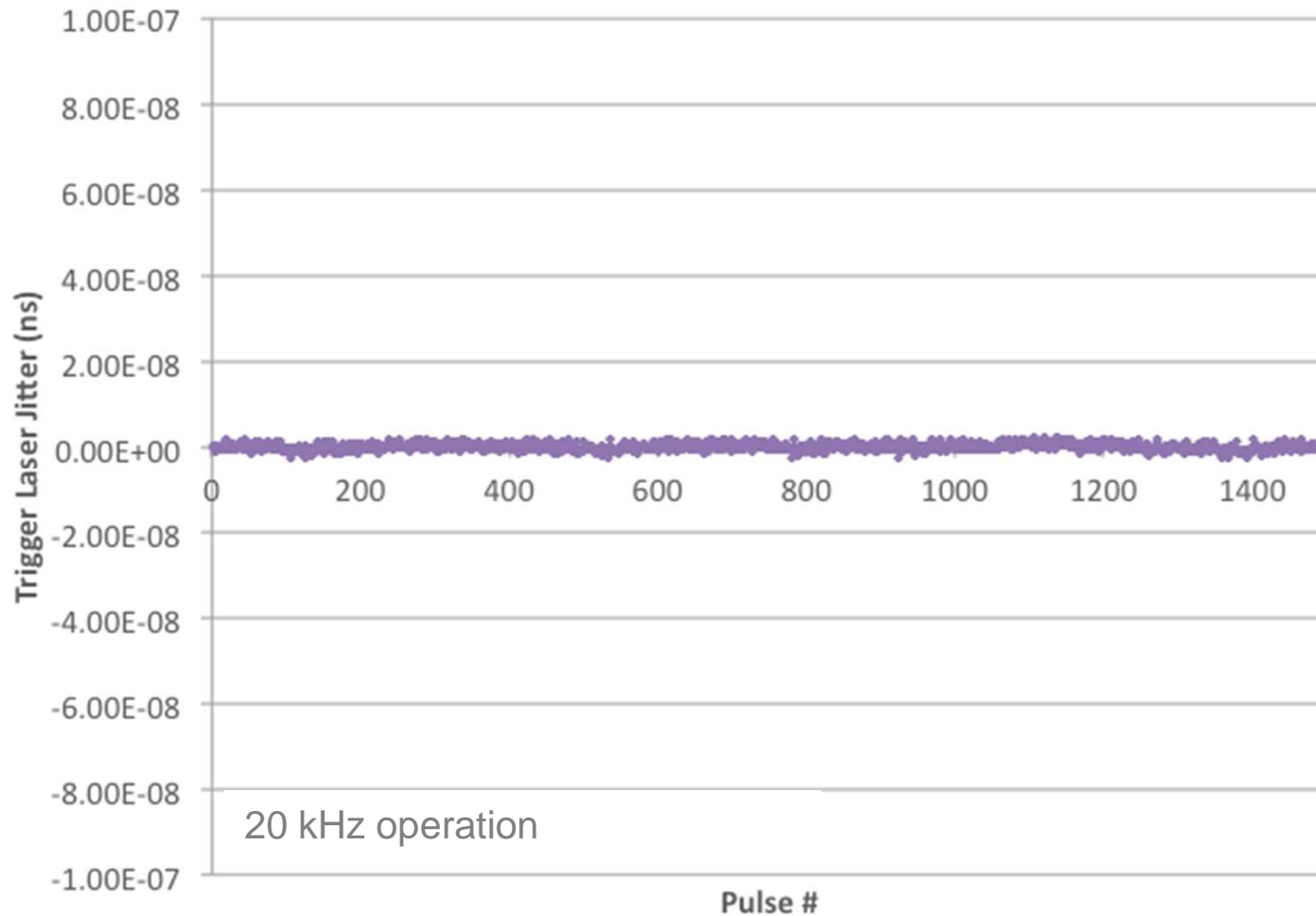
→ Tin vaporization repeatability

- Trigger laser stability makes Tin vaporization and plasma production highly reproducible



LDP Stability = Trigger Laser Timing Stability

- The jitter between trigger laser pulses is kept $\ll 1$ ns



→ No timing instability

→ Tin vaporization is highly reproducible

LDP Stability = Tin Flow Uniformity

- The amount of Tin vaporized (with each trigger pulse) is highly repeatable



Will EUVL Ever Be A Reality ?

- Will EUV light sources ever scale ?
- Could EUV light sources be turned into a product ?
- Do we have our priorities right ?
- **Conclusions**

USHIO
G R O U P

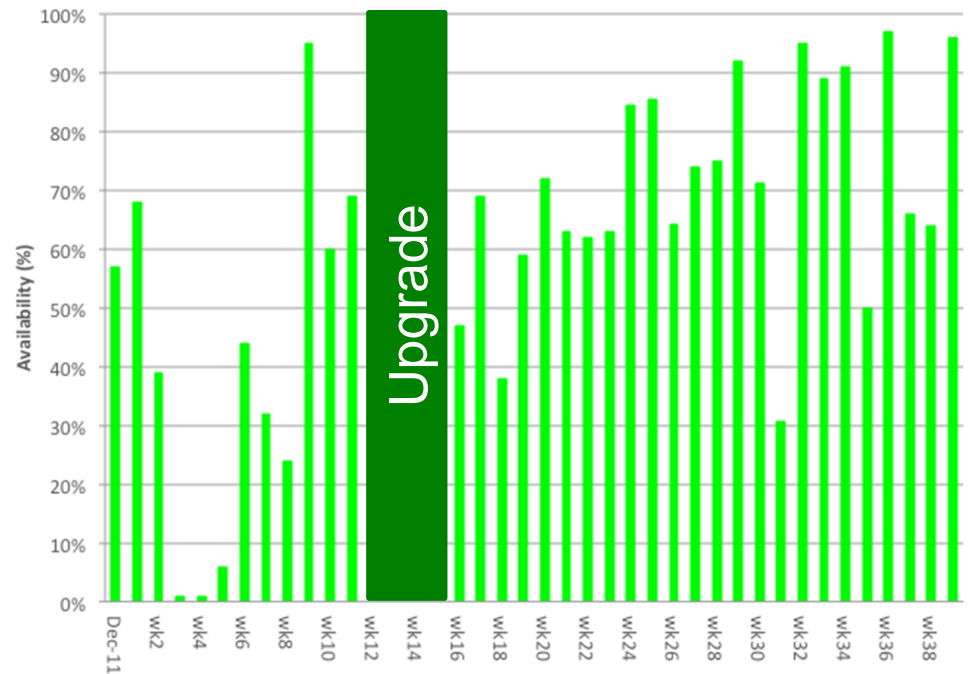
XTREME's 2012 Objectives

- To drastically improve and stabilize the reliability of XT's 3100 source at IMEC to enable Affiliate Chipmakers to develop their EUV process

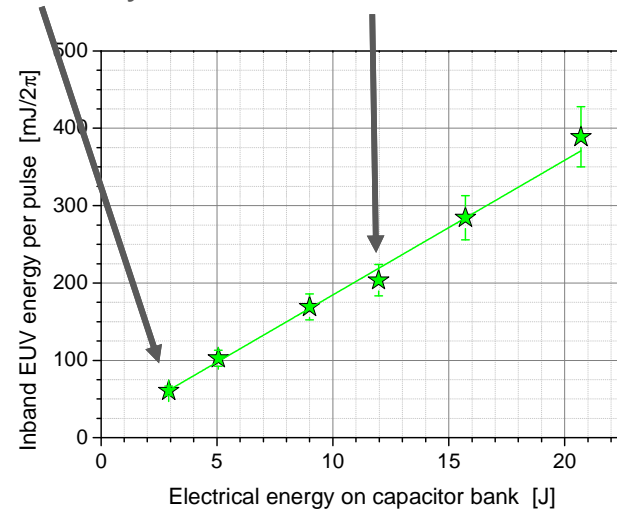
☑ Done

- To prove LDP long term scalability

☑ Done



~ IMEC Today ~ NXE:3300 B >> NXE:3300 B



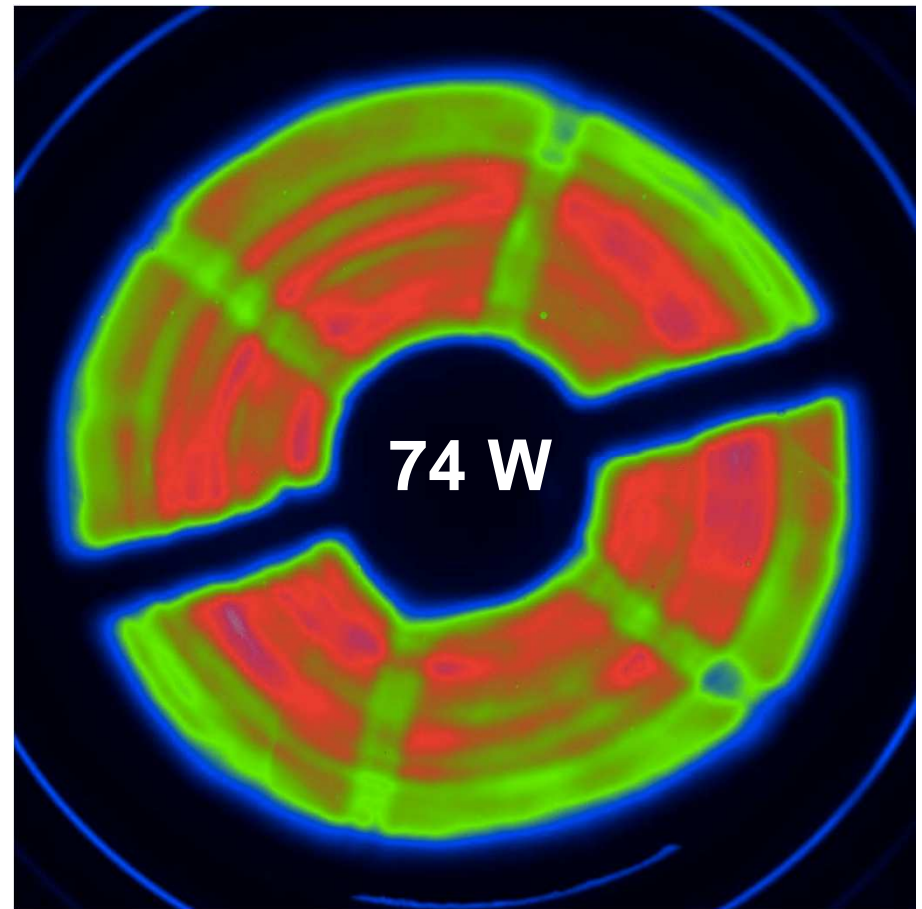
XTREME's 2012 Objectives

- To resume power scaling and demonstrate 50W

Done

- To upgrade XT's 3100 source at IMEC for higher power

Soon



Conclusions

- EUV is **a reality in the making** supported by recent progresses of LDP
- **No more claims. Results are in:**
 - LDP is scalable in the long term
 - **74W power after IF** was demonstrated on an integrated source
 - LDP technology is now being turned into a viable product and **high uptime** is achieved
- The night is always darker before dawn ... but the **EUV revolution is around the corner**

USHIO
G R O U P

Acknowledgments

- XTREME would like to acknowledge this work has been possible thanks to a very valuable and fruitful collaboration with Fraunhofer ILT
- XTREME would also like to thank NEDO for their continued support

USHIO
G R O U P

THANK YOU VERY MUCH FOR YOUR ATTENTION



XTREME technologies GmbH
www.xtremetec.de

USHIO
G R O U P